

PAMS Technical Documentation

NSW-3 Series Transceivers

Chapter 3

System Module UT4U/UT4RM

CONTENTS

| | Page No |
|--------------------------------------------------------|----------------|
| Transceiver NSW-3 | 3 - 6 |
| Introduction | 3 - 6 |
| Functional Description | 3 - 6 |
| Interconnection Diagram | 3 - 7 |
| System Module | 3 - 8 |
| External and Internal Connectors | 3 - 8 |
| System Connector Signals | 3 - 9 |
| RF-Connector | 3 - 9 |
| Battery Contacts | 3 - 10 |
| Operating Conditions | 3 - 10 |
| Functional Description | 3 - 11 |
| Modes of Operation | 3 - 11 |
| Analog Control Channel (ACCH) Mode | 3 - 11 |
| Analog Voice Channel (AVCH) Mode | 3 - 12 |
| Digital Control Channel (DCCH) 800 MHz Mode | 3 - 12 |
| Digital Traffic Channel (DTCH) 800 MHz Mode | 3 - 13 |
| Digital Control Channel (DCCH) 1900 MHz Mode | 3 - 13 |
| Digital Traffic Channel (DTCH) 1900 MHz Mode | 3 - 13 |
| Out of Range (OOR) Mode | 3 - 13 |
| Locals Mode | 3 - 13 |
| Power Distribution Diagram | 3 - 14 |
| External interfaces | 3 - 15 |
| Signals between baseband and User Interface section .. | 3 - 15 |
| User Interface module connection | 3 - 15 |
| Earphone | 3 - 15 |
| Buzzer | 3 - 15 |
| Baseband Module | 3 - 16 |
| Power Distribution | 3 - 16 |
| Charging Control | 3 - 17 |
| 2-wire charging | 3 - 17 |
| 3-wire charging | 3 - 18 |
| Watchdog | 3 - 18 |
| Power up | 3 - 19 |
| Power up when power-button is pushed | 3 - 19 |
| IBI (Intelligent Battery Interface) | 3 - 20 |
| Mixed trigger to power up | 3 - 20 |
| Power Off | 3 - 20 |
| Power off by pushing Power-key | 3 - 20 |
| Power off when battery voltage low | 3 - 21 |
| Power off when fault in the transmitter | 3 - 21 |
| Sleep Mode | 3 - 21 |

| | |
|---------------------------------------------------------|--------|
| Waking up from the Sleep-mode | 3 - 21 |
| Baseband submodules | 3 - 22 |
| CTRLU | 3 - 22 |
| MCU main features | 3 - 22 |
| DSP main features | 3 - 23 |
| System Logic main features | 3 - 23 |
| Memories | 3 - 23 |
| AUDIO-RF | 3 - 24 |
| Cobba main features | 3 - 24 |
| Speech processing | 3 - 25 |
| Alert Signal Generation | 3 - 25 |
| PWRU | 3 - 26 |
| CCONT main features | 3 - 26 |
| CHAPS main features | 3 - 26 |
| RF Module | 3 - 27 |
| RF Frequency Plan | 3 - 27 |
| DC Characteristics | 3 - 27 |
| Power Distribution Diagram | 3 - 27 |
| Power Distribution - Typical Currents (dual band) | 3 - 30 |
| Functional Description | 3 - 31 |
| Receiver | 3 - 31 |
| DAMPS800 RX | 3 - 31 |
| TDMA 1900 RX | 3 - 32 |
| Transmitter | 3 - 32 |
| DAMPS800 TX | 3 - 32 |
| TDMA 1900 RX | 3 - 32 |
| Frequency Synthesizers | 3 - 33 |
| DAMPS800 operation | 3 - 33 |
| TDMA 1900 operation | 3 - 33 |
| Supply voltages in different modes of operation | 3 - 34 |
| Software Compensations | 3 - 34 |
| Power Levels (TXC) vs. Temperature | 3 - 34 |
| Power Levels (TXC) vs. Channel | 3 - 34 |
| Power levels vs. Battery Voltage | 3 - 35 |
| TX Power Up/Down Ramps | 3 - 35 |
| Modulator Output Level | 3 - 35 |
| Digital Mode RSSI | 3 - 35 |
| RF Block Specifications | 3 - 36 |
| Receiver | 3 - 36 |
| DAMPS 800 Mhz Front End | 3 - 36 |
| TDMA 1900 Mhz Front End | 3 - 36 |
| First IF Filter | 3 - 36 |
| Transmitter | 3 - 37 |
| RF Characteristics | 3 - 37 |
| Power Levels | 3 - 37 |

| | |
|---------------------------------------------------------------------------|---------|
| Synthesizers | 3 - 37 |
| UHF | 3 - 37 |
| VHF | 3 - 38 |
| Output Levels | 3 - 39 |
| Connections | 3 - 40 |
| RF-Baseband signals | 3 - 40 |
| Data Interface and Timing | 3 - 46 |
| TDMA 1900 UHF Synthesizer Timing Control | 3 - 46 |
| Digital control channels | 3 - 48 |
| Analog control channel | 3 - 50 |
| Parts list of UT4U (Phase 1 EDMS Issue 11.3) Code:0200890 | 3 - 51 |
| Parts list of UT4RM (Phase 2 EDMS Issue 5.0) Code:0201238 | 3 - 62 |
| Schematic Diagrams: | |
| Circuit Diagram of System Blocks (Version 14 Edit 187) layout 16 | 3/A3-1 |
| Circuit Diagram of Power Supply (Version 14 Edit 284) layout 16 | 3/A3-2 |
| Circuit Diagram of CTRLU Block (Version 14 Edit 285) layout 16 | 3/A3-3 |
| Circuit Diagram of Audio (Version 14 Edit 211) for layout version 16 ... | 3/A3-4 |
| Circuit Diagram of Transmitter (Version 15 Edit 545) layout 16 | 3/A3-5 |
| Circuit Diagram of Receiver (Version 15 Edit 124) layout 16 | 3/A3-6 |
| Circuit Diagram of Synthesizer (Version 15 Edit 151) layout 16 | 3/A3-7 |
| Circuit Diagram of RF Block (Version 15 Edit 101) layout 16 | 3/A3-8 |
| Circuit Diagram of RF-BB Interface (Version 15 Edit 67) layout 16 | 3/A3-9 |
| Layout Diagram of UT4U (Layout version 16) | 3/A3-10 |
| Circuit D. of System Blocks (Version 04.27 Edit 204) for Phase 2 v.1..... | 3/A3-1 |
| Circuit D. of Power Supply (Version 04.27 Edit 300) for Phase 2 v.1..... | 3/A3-2 |
| Circuit D. of CTRLU Block (Version 04.27 Edit 293) for Phase 2 v.1..... | 3/A3-3 |
| Circuit D. of Audio (Version 04.27 Edit 241) for Phase 2 v.1..... | 3/A3-4 |
| Circuit D. of Transmitter (Version 04.27 Edit 583) for Phase 2 v.1..... | 3/A3-5 |
| Circuit D. of Receiver (Version 04.27 Edit 131) for Phase 2 v.1..... | 3/A3-6 |
| Circuit D. of Synthesizer (Version 04.27 Edit 157) for Phase 2 v.1 | 3/A3-7 |
| Circuit D. of RF Block (Version 04.27 Edit 105) for Phase 2 v.1..... | 3/A3-8 |
| Layout Diagram 1/2 of UT4RM (Phase 2 v.1) | 3/A3-9 |
| Layout Diagram 2/2 of UT4RM (Phase 2 v.1) | 3/A3-10 |

Transceiver NSW-3

Introduction

The NSW-3 is a dualband/dualmode radio transceiver unit for the US TDMA 800/1900 cellular mobile phone networks. The transceiver is a true 3 V transceiver.

The transceiver consists of a System/RF module (UT4U Phase 1 and UT4RM Phase 2), an User interface module (UE4) and assembly parts.

The purpose of the baseband module is to control the phone and process audio signals to and from the RF. The module also controls the user interface.

The Dual-band RF-module is capable of seamless operation between 800 MHz and 1900 MHz bands. In practise this means capability for cross-band hand-offs and maca-measurements.

The transceiver has full graphic display and two soft key based user interface.

The antenna is a fixed helix. External antenna connection is provided by rear RF connector

Functional Description

There are five different operation modes:

1. power off mode
2. sleep mode
3. active mode
4. charge mode
5. local mode

In the (1) power off mode only the circuits needed for power up are supplied.

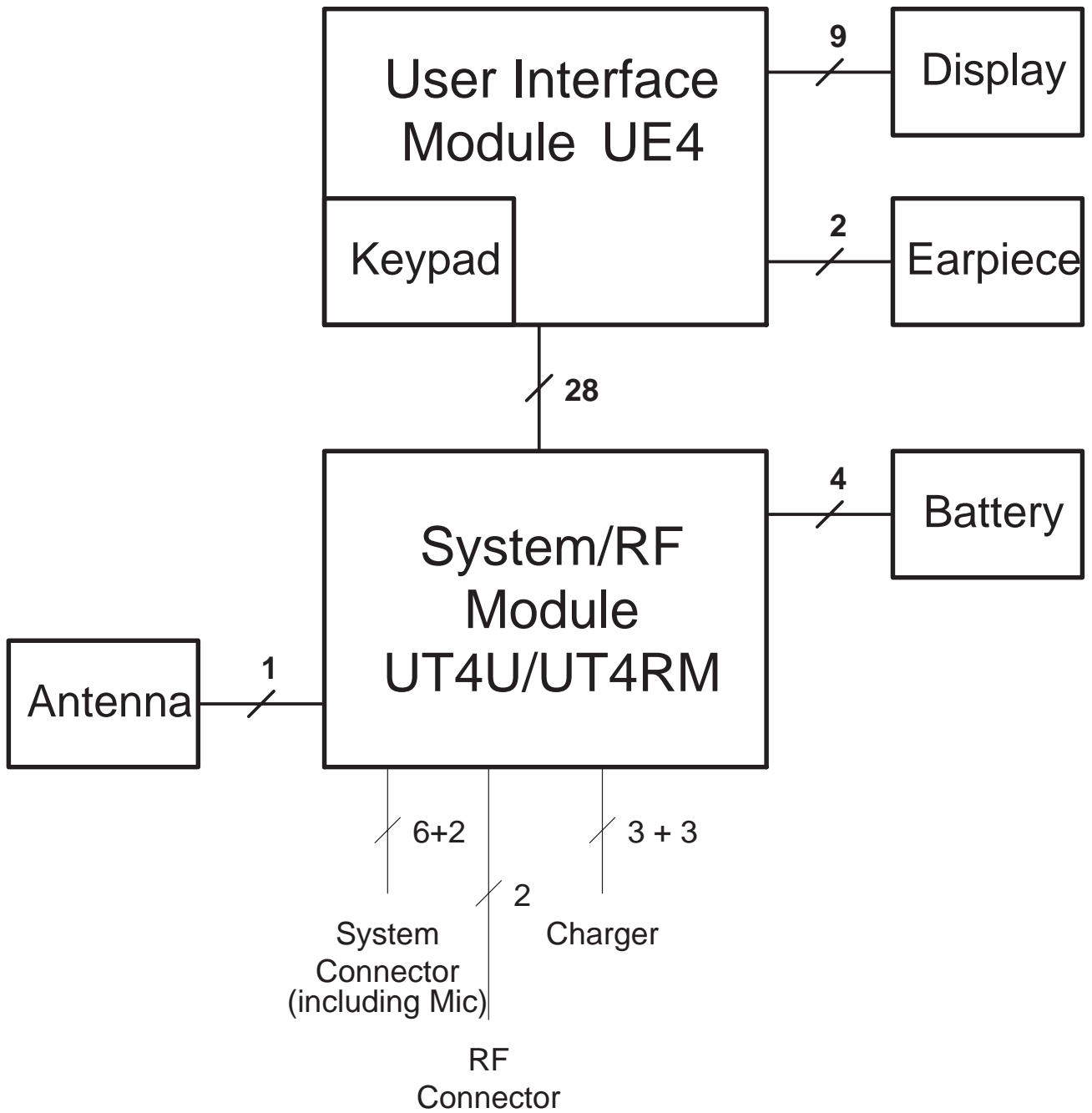
In the (2) sleep mode all circuits are powered down and only sleep clock is running.

In the (3) active mode all the circuits are supplied with power although some parts might be in the idle state part of the time.

The (4) charge mode is effective in parallel with all previous modes. The charge mode itself consists of two different states, i.e. the charge and the maintenance mode.

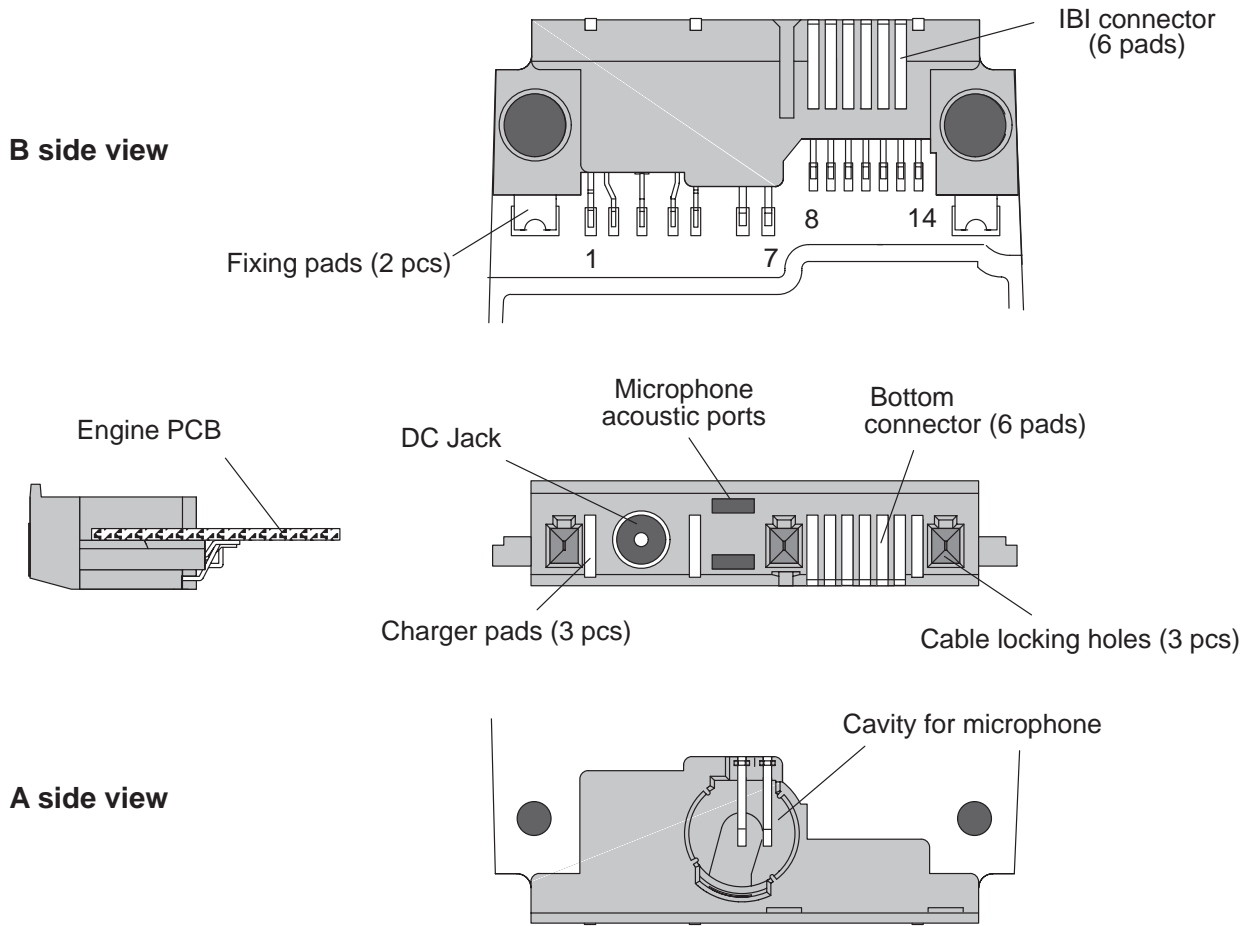
The (5) local mode is used for alignment and testing.

Interconnection Diagram



System Module

External and Internal Connectors

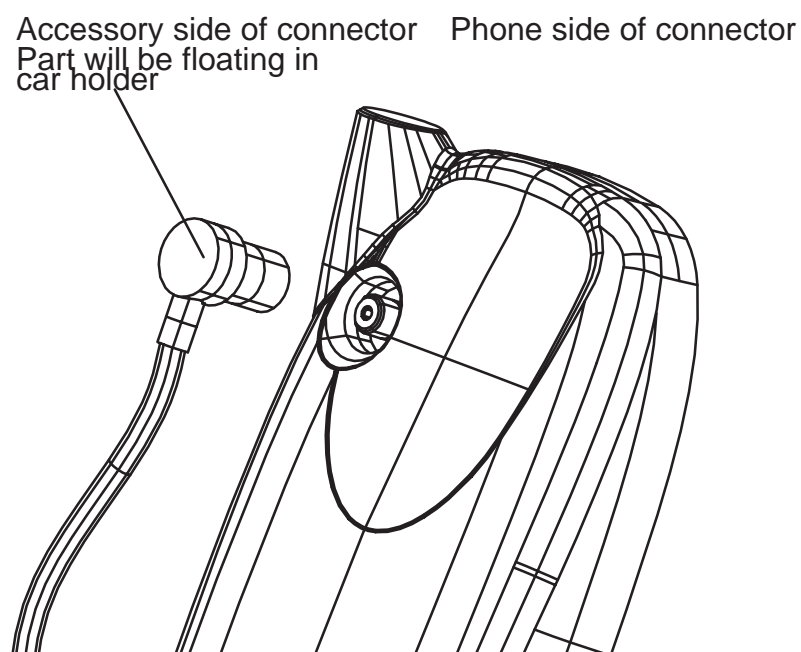


System Connector Signals

| Pin | Name | Function | Description |
|-----|-----------|-------------------------|-----------------------------------|
| 1 | V_IN | Bottom charger contacts | Charging voltage. |
| 2 | L_GND | DC Jack | Logic and charging ground. |
| 3 | V_IN | DC Jack | Charging voltage. |
| 4 | CHRG_CTRL | DC Jack | Charger control. |
| 5 | CHRG_CTRL | Bottom charger contacts | Charger control. |
| 6 | MICP | Microphone | Microphone signal, positive node. |
| 7 | MICN | Microphone | Microphone signal, negative node. |
| 8 | XMIC | Bottom & IBI connectors | Analog audio input. |
| 9 | SGND | Bottom & IBI connectors | Audio signal ground. |
| 10 | XEAR | Bottom & IBI connectors | Analog audio output. |
| 11 | MBUS | Bottom & IBI connectors | Bidirectional serial bus. |
| 12 | FBUS_RX | Bottom & IBI connectors | Serial data in. |
| 13 | FBUS_TX | Bottom & IBI connectors | Serial data out. |
| 14 | L_GND | Bottom charger contacts | Logic and charging ground. |

RF-Connector

The RF-connector is needed to utilize the external antenna with Car Cradle. The RF-connector is located on the back side of the transceiver on the top section. The connector is plug type connector with special mechanical switching.



Battery Contacts

| Pin | Name | Function | Description |
|-----|-------|----------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------|
| 1 | BVOLT | Battery voltage | Battery voltage |
| 2 | BSI | Battery Size Indicator | Input voltage |
| 3 | BTEMP | Battery temperature indication Phone power up Battery power up PWM to VIBRA BATTERY | Input voltage Input voltage Output voltage PWM output signal frequency |
| 4 | BGND | | Ground |

Operating Conditions

| Environmental condition | Ambient temperature | Notes |
|-----------------------------------|--------------------------------------------|-------------------------------------------------------------------------------|
| Normal operation conditions | +7 °C ... +40 °C | Specifications fulfilled and fast charging possible |
| Extreme operation conditions | -10 °C ... +40 °C | Specifications fulfilled |
| Reduced performance conditions | +40 °C ... +60 °C | Operational only for short periods |
| Intermittent operation conditions | -40 °C ... -30 °C and +60 °C ... +80 °C | Operation maybe not possible but attempt to operate will not damage the phone |
| Cessation of operation | <-40 °C and >80 °C | No storage or operation is allowed |
| Long term storage conditions | 0 °C ... +40 °C | Battery only up to +30 °C ! |
| Short term storage, max. 24 h | -40 °C ... +80 °C | Cumulative for life-time of battery |
| LCD operation | -30 °C ... +70 °C | Functions are delayed in low temperatures |

Functional Description

The UT4U (Phase 1) / UT4RM (Phase2) engine consist of a Baseband/RF module with connections to a separate User Interface module. The baseband and RF submodules are interconnected by the PCB wiring. The engine can be connected to accessories via a bottom system connector and an Intelligent Battery Interface (IBI) connector. The difference between Phase 1 and Phase 2 is the memory size and some layout and component changes.

RF Submodule

The RF submodule receives and demodulates radio frequency signals from a base station and transmits modulated RF signals to a base station. It consists of functional submodules:

- Receiver,
- Frequency Synthesizer
- Transmitter

The RF submodule can further be divided into lower band and upper band functions.

Baseband submodule

The Baseband module comprises audio, control, signal processing and power supply functions. It consists of the following functional submodules:

- CTRLU (Control Unit; MCU, DSP, logic and memories),
- PWRU (Power Supply; regulators and charging)
- AUDIO_RF (audio coding, RF-BB interface).

Modes of Operation

The UT4U/UT4RM operates in seven cellular modes and a local mode for service:

- Analog Control Channel (ACCH) 800 MHz Mode,
- Analog Voice Channel (AVCH) 800 MHz Mode,
- Digital Control Channel (DCCH) 800 MHz Mode,
- Digital Traffic Channel (DTCH) 800 MHz Mode,
- Digital Control Channel (DCCH) 1900 MHz Mode,
- Digital Traffic Channel (DTCH) 1900 MHz Mode,
- Out of Range (OOR) Mode,
- Locals mode, used by Production and After Sales.

Analog Control Channel (ACCH) Mode

On analog control channel mode the phone receives continuous signalling messages on Forward Control Channel (FOCC) from the base station, being

most of the time in IDLE mode. Only the receiver part is on. The phone scans the preferred dedicated control channels to find and lock to the strongest channel for reading information from this control channel.

DSP is not used on ACCH (it stays in sleep mode), except during channel scanning for loading the synthesizers.

As a separate sleep clock is used, also the VCTCXO can be turned off periodically with the RF parts. Only the sleep clock and necessary timers in the MCU are operational.

When registration is demanded the phone sends (TX on) its' data on Reverse Control Channel (RECC) to the base station. The phone's location is updated in the switching office.

If a call is initiated, either by the user or the base station, the phone moves to the allocated analog voice channel or digital traffic channel depending on the orders by the base station.

Analog Voice Channel (AVCH) Mode

The phone receives and transmits analog audio signal. All circuitry is powered on (except the receiver parts used only in digital modes). DSP does the audio processing and in Hands Free mode also performs the echo-cancellation and HF algorithms. The COBBA IC makes A/D conversion for the MIC signal, and D/A conversion for the EAR signal.

With audio signal also the Supervisory Audio Tone (SAT) is being received from the base station. The SAT frequency can be 5970 Hz, 6000Hz or 6030 Hz, defined by the base station. The DSP phase lock loop locks to the SAT, detects if the frequency is the expected one and examines the signal quality. DSP reports SAT quality figures regularly to the MCU. The received SAT signal is transmitted back (transponded) to the base station.

The base station can send signalling messages on Forward Voice Channel (FVC) to the phone, by replacing the audio with a burst of Wide Band Data (WBD). These are typically hand-off or power level messages. The RX modem in System Logic receives the signalling message burst and gives an interrupt to the MCU for reading the data. MCU gives a message to DSP to mute the audio path during the burst. MCU can acknowledge the messages on Reverse Voice Channel (RVC), where DSP sends the WBD to transmitter RF.

Digital Control Channel (DCCH) 800 MHz Mode

On digital control channel (DCCH) DSP receives the paging information from the Paging channels and sends the messages to MCU for processing.

Each Hyperframe (HFC) comprises two Superframes (SF), the Primary (p) and the Secondary (s) paging frame. The assigned Page Frame Class (PFC) defines the frames which must be received, and thus defines when the receiver must be on.

The phone is in sleep mode between the received time slots. The sleep clock timer is set and the MCU, DSP and RF parts (including VCTCXO) are powered down. Only the sleep clock and the respective timers are running.

From DCCH the phone may be ordered to analog control channel or to analog or digital traffic channel.

Digital Traffic Channel (DTCH) 800 MHz Mode

Digital Voice Channel (S-DTCH)

On digital voice channel mode the DSP processes the speech signal in 20 ms time slots. The DSP performs the speech and channel functions in time shared fashion and is in sleep mode whenever possible. The RX and TX parts are powered on and off according to the slot timing. The MCU is waken up mainly by DSP, when there is signalling information for the Cellular Software.

Digital Data Channel (D-DTCH)

In Digital Data Channel Mode audio processing is not needed and the audio circuitry can be shut down. Otherwise the mode is similar to Digital Voice Channel Mode.

Digital Control Channel (DCCH) 1900 MHz Mode

Similar to Digital Control Channel 800 MHz Mode.

Digital Traffic Channel (DTCH) 1900 MHz Mode

Similar to Digital Traffic Channel 800 MHz Modes.

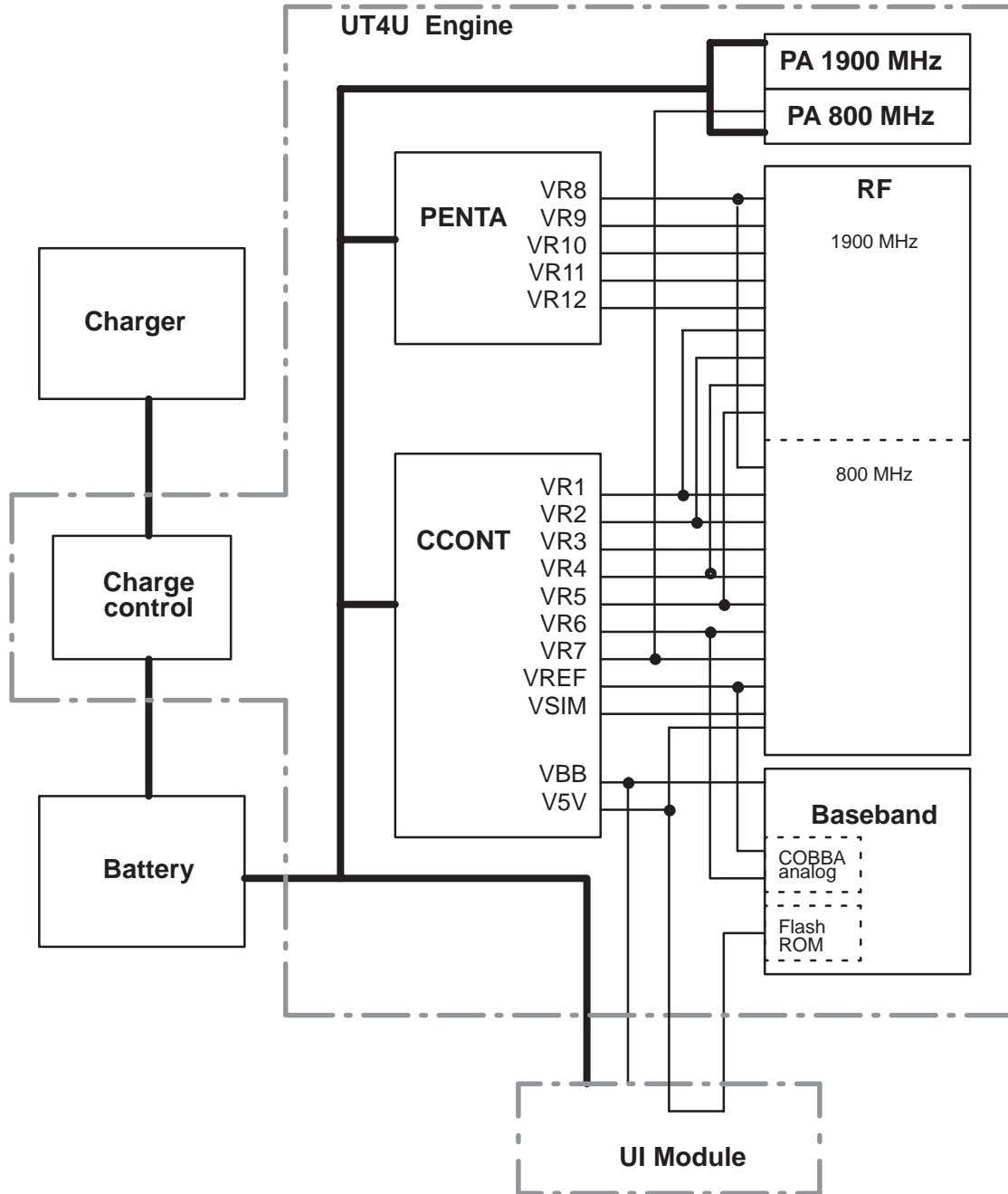
Out of Range (OOR) Mode

If the phone can't find a signal from the base station on any control channel (analog or digital) it can go into OOR mode for power saving. All RF circuits are powered down and the baseband circuits in a low power mode, the VCTCXO stopped and only the sleep clock running. After a programmable timer in the MCU has elapsed the phone turns the receiver on and tries to receive signalling data from a base station. If it succeeds, the phone goes to standby mode on analog or digital control channel. If the connection can not be established the phone returns to OOR mode until the timer elapses again.

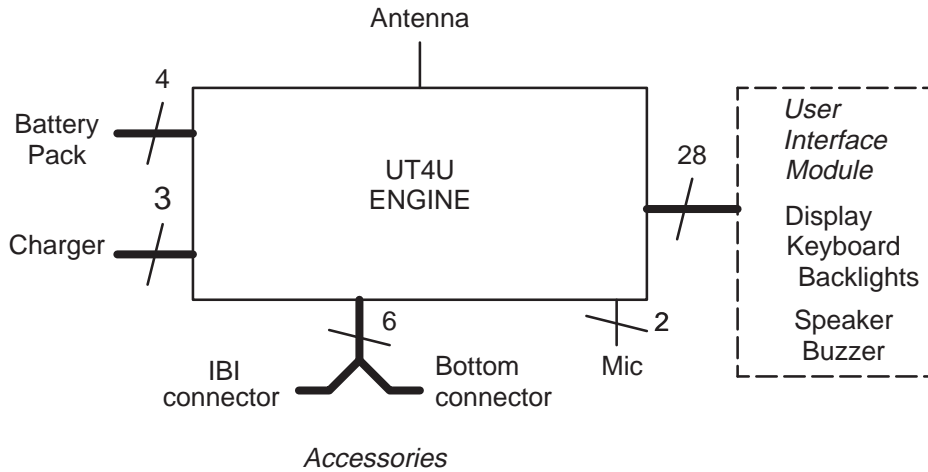
Locals Mode

Locals mode is used for testing purposes. The Cellular Software is stopped (no signalling to base station), and the phone is controlled by MBUS/FBUS messages by the controlling PC.

Power Distribution Diagram



External interfaces



| Connector Name | Notes |
|----------------------------------|-------------------------------------------------------------------------------|
| Bottom connector + IBI connector | Includes control, data, charging and audio signals |
| UI-connector | includes keyboard, backlight, display, buzzer, call led, and earpiece signals |
| Battery connector | VBAT, GND, BTYPE, BTEMP |
| RF-interface | Connection |

Signals between baseband and User Interface section

The User interface section is implemented on a separate UI board, which connects to the engine board with a board to board spring connector.

User Interface module connection

The User interface section comprises the keyboard with keyboard backlights, display module with display lights, an earphone and a buzzer.

Earphone

The internal earphone is connected to the UI board by means of mounting springs. The low impedance, dynamic type earphone is connected to a differential output in the COBBA audio codec. The voltage level at each output is given as reference to ground. The earphone levels are given to 32 ohm load.

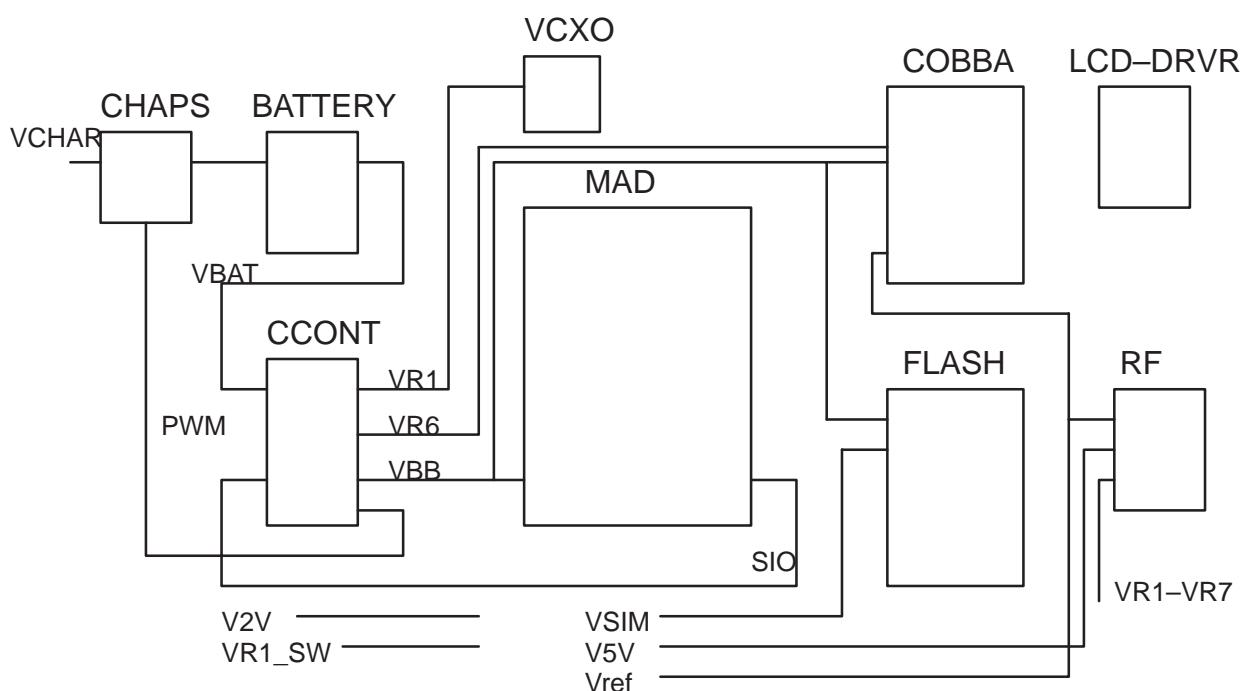
Buzzer

Alerting tones and/or melodies as a signal of an incoming call are generated with a buzzer that is controlled with a PWM signal by the MAD. The buzzer is a SMD device placed on the UI board.

Baseband Module

Power Distribution

In normal operation the baseband is powered from the phone's battery. The battery consists of three Nickel-cells. There is also a possibility to use batteries consisting of one Lithium-cell. An external charger can be used for recharging the battery and supplying power to the phone. The charger can be either so called fast charger, which can deliver supply current up to 850 mA or a standard charger that can deliver around 300 mA.



Battery voltage VBAT is connected to the CCONT which regulates all the supply voltages VBB, VR1–VR7, V2V, VR1_SW, VSIM and V5V. VR7 is divided into VR7 and VR7_bias. VR7_bias is for PA in RF analog mode to change its operation point to optimum for nonlinear FM modulation. CCONT enables automatically VR1, VBB, V2V_core, VR6 and Vref in power-up.

VBB is used as baseband power supply for all digital parts, and it is constantly on whenever the phone is powered up. There is also another Baseband voltage, V2V, which is reserved for later version of MAD circuit. V2V will be used as a lower core voltage for MAD internal parts, by supplying it to specific MAD core voltage pins. Until that moment, the VBB is used for all MAD pins. The VSIM can be used as programming voltage for the Flash memory, if re-flashing is needed after initial flash programming in production. V5V is used for RF parts only.

VR1 is used for the VCXO supply. VR1_SW is derived from VR1 inside the CCONT, and is actually the same voltage, but it can be separately

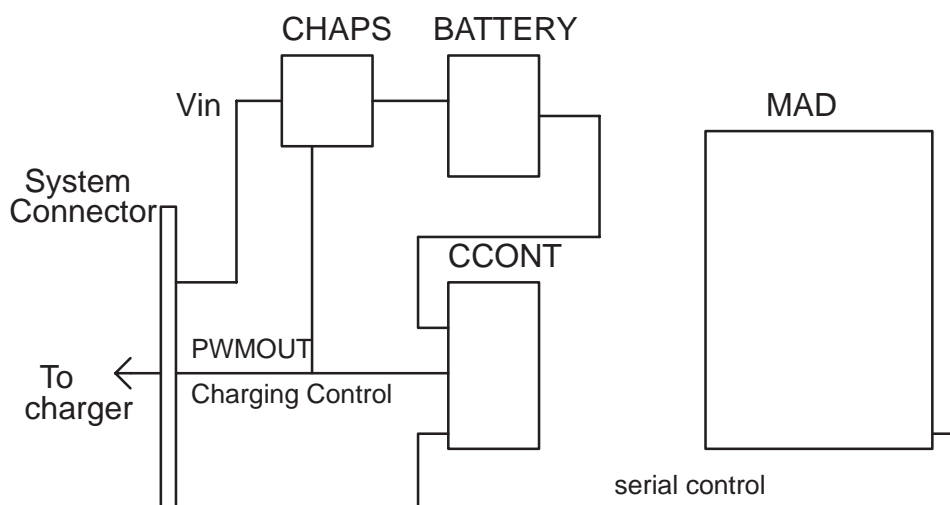
switched on and off. This VR1_SW is used as bias voltage for microphone, during talk modes. Voltage VR6 is used in the COBBA for analog parts and also in RF parts. The RFCEN signal to the CCONT controls both the VR1 and VR6 regulators; they can be switched off in sleep modes, during standby.

The CCONT regulators are controlled either through the SIO from the MAD or timing sensitive regulators are controlled directly to their control pins. These two control methods form a logical OR-function, i.e. the regulator is enabled when either of the controls is active. Most of the regulators can be individually controlled.

The CHAPS connects the charger voltage (VCHAR) to battery. The MCU of the MAD controls the charging through the CCONT. The MAD sets the parameters to the PWM-generator in the CCONT and PWM-output controls the charging voltage in the charger.

When the battery voltage is under 3.0V, the CHAPS controls independently the charging current to battery.

Charging Control



Charging is controlled by the MCU SW, which writes control data to the CCONT via the serial bus. The CCONT output pin PWMOUT (Pulse Width Modulation) can be used to control both the charger and the CHAPS circuit in the phone.

2-wire charging

With 2-wire charging the charger provides constant output current, and the charging is controlled by the PWMOUT signal from the CCONT to the CHAPS. The PWMOUT signal frequency is selected to be 1 Hz, and the charging switch in the CHAPS is pulsed on and off at this frequency. The

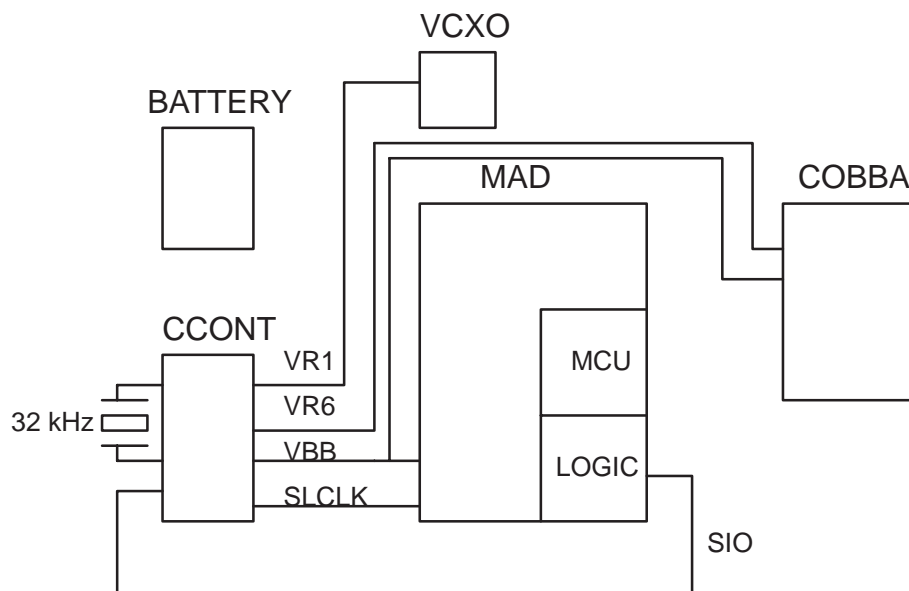
final charged energy to the battery is controlled by adjusting the PWMOUT signal pulse width.

Both the PWMOUT frequency selection and the pulse width control are made by the MCU which writes these values to the CCONT.

3-wire charging

With 3-wire charging the charger provides an adjustable output current, and the charging is controlled by the PWMOUT signal from the CCONT to the Charger, with the bottom connector signal. The PWMOUT signal frequency is selected to be 32 Hz, and the charger output voltage is controlled by adjusting the PWMOUT signal pulse width. The charger switch in the CHAPS is constantly on in this case.

Watchdog



Both MAD and CCONT include a watchdog, and both use the 32 kHz sleep clock. The watchdog in MAD is the primary one, and this is called SW-watchdog. MCU has to update it regularly. If it is not updated, logic inside MAD gives reset to MAD. After the reset, MCU can read an internal status bit to see the reason for reset, whether it was from MAD or CCONT. The SW-watchdog delay can be set between 0 and 63 seconds at 250 millisecond steps; and after power-up the default value is the max. time.

MAD must reset CCONT watchdog regularly. CCONT watchdog time can be set through SIO between 0 and 63 seconds at 1 second steps. After power-up the default value is 32 seconds. If watchdog elapses, CCONT will cut off all supply voltages.

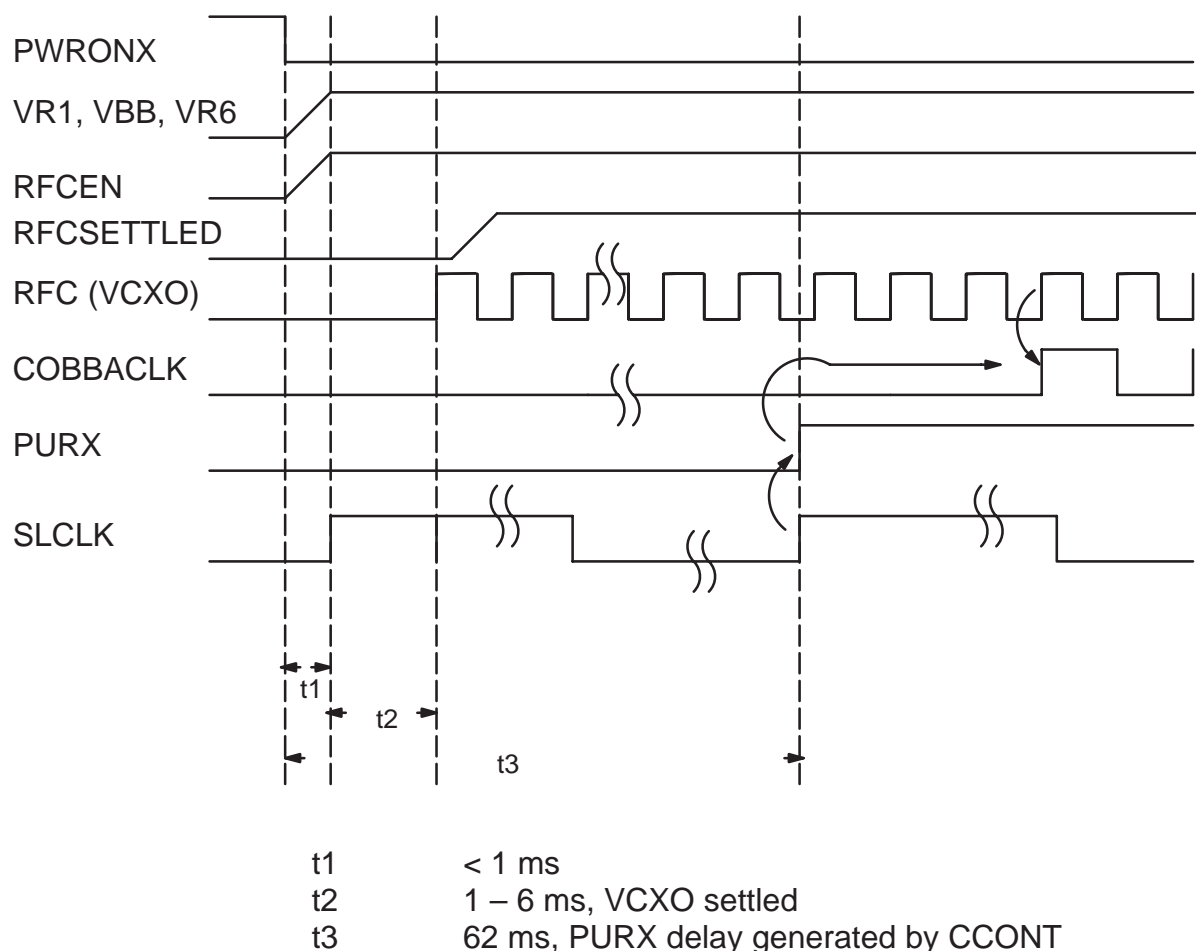
After total shut down the phone can be re-started through any normal power-up procedure.

Power up

When the battery is connected to the phone, nothing will happen until the power-up procedure is initiated, for instance by pressing the power-button (or by connecting charger voltage). After that the 32kHz crystal oscillator of CCONT is started (can take up to 1 sec), as well as the regulators are powered up.

If power down is done, and the battery remains connected, the 32 kHz crystal oscillator keeps still running in the CCONT. When power-up is initiated again, the complete power-up sequence is described in the figure below. This time the power-up sequence is faster, because the oscillator is already running.

Power up when power-button is pushed



After the PWR-key has been pushed, the CCONT gives PURX reset to the MAD and COBBA, and turns on the VR1, VBB and VR6 regulators (if battery voltage has exceeded 3.0 V). VR1 supplies the VCXO, VBB supplies the MAD and digital parts of the COBBA, and VR6 supplies analog

parts of the COBBA and some RF parts. After the initial delay t_2 the VCXO starts to give proper RFC to the COBBA that further divides it to COBBACLK for the MAD. The COBBA will output the COBBACLK only after the PURX reset has been removed. After delay t_3 the CCONT releases PURX and the MAD can take control of the operation of the phone.

After that the MCU-SW in the MAD detects that the PWR-key is still pushed and shows the user that the phone is powering up by starting the LCD and turning on the lights. The MCU-SW must start also the RF receiver parts at this point.

The CCONT will automatically power-up also the VSIM-regulator (used for possible reFlashing), regardless of the control pin SIMPWR state, and the regulator default voltage is 3V.

The V5V-regulator (for RF) default value is OFF in power-up, and can be controlled to ON via serial bus when needed.

IBI (Intelligent Battery Interface)

The phone can be powered up by external device (accessory or similar) by providing a start pulse to the battery signal BTEMP; this is detected by the CCONT. After that the power-up procedure is similar to pushing the power-button.

Mixed trigger to power up

It is possible that the PWR-key is pushed during a charger initiated power-up procedure or that the charger is connected during a PWR-key initiated power up procedure. In this kind of circumstances the power-up procedure (in HW point of view) continues as nothing had happened.

When the Baseband HW is working normally and the SW is running, the SW detects that both conditions are fulfilled and then acts accordingly.

Power Off

Power off by pushing Power-key

The MAD (MCU SW) detects that the PWR-key is pressed long enough time. After that the lights and LCD are turned off. The MCU stops all the activities it was doing (e.g. ends a call), sends power off command to CCONT (i.e. gives a short watchdog time) and goes to idle-task. After the delay the CCONT cuts all the supply voltages from the phone. Only the 32 kHz sleep clock remains running.

Note that the phone doesn't go to power off (from HW point of view) when the charger is connected and PWR-key is pushed. It is shown to the user that the phone is in power off, but in fact the phone is just acting being powered off (this state is usually called "acting dead" state).

Power off when battery voltage low

During normal discharge the phone indicates the user that the battery will drain after some time. If not recharged, the SW detects that battery voltage is too low and shuts the phone off through a normal power down procedure.

Anyway, if the SW fails to power down the phone, the CCONT resets and powers down the phone if the battery voltage drops below 2.8V.

Power off when fault in transmitter

If the MAD receives fault indication from the line TXF, that the transmitter is on although it shouldn't be, the control SW will power down the phone.

Sleep Mode

The phone can enter the SLEEP only when both the MCU and DSP request it. A substantial amount of current is saved in the SLEEP. When going to the SLEEP following things happen :

1. Both the MCU and DSP enable sleep mode, set the sleep timer and enter sleep mode
2. RFCEN and RFCSETTLED → 0 → COBBACLK will stop (gated in the COBBA). Also VR1 is disabled → the VCXO supply voltage is cut off → the RFC stops.
3. LCD display remains the same, no changes
4. Sleep clock (SLCLK) and watchdog in the CCONT running
5. Sleep counter in the MAD running, uses SLCLK

Waking up from Sleep-mode

In a typical case the phone leaves the SLEEP-mode when the SLEEP-counter in MAD expires. After that MAD enables VR1 ⇒ the VCXO starts running ⇒ after a pre-programmed delay RFCSETTLED rises ⇒ the MAD receives COBBACLK clock ⇒ the MAD operation re-starts.

There are also many other cases when the SLEEP mode can be interrupted, in these cases the MAD enables the VR1 and operation is started similarly

- some MCU or DSP timer expires
- DSP regular event interrupt happens
- MBUS activity is detected
- FBUS activity is detected
- Charger is connected, Charger interrupt to the MAD
- any key on keyboard is pressed, interrupt to the MAD
- HEADSETINT, from system connector XMIC line (EAD)
- HOOKINT, from system connector XEAR line

Baseband submodules

CTRLU

The CTRLU comprises the MAD ASIC (MCU, DSP, System Logic) and Memories.

The environment consists of three memory circuits (FLASH, SRAM, EEPROM), a 22-bit address bus and a 8/16-bit data bus. Besides there are ROM1SELX, ROM2SELX, RAMSELX and EEPROMSELX signals for chip selection.

MCU main features

System control

Cellular Software (CS)

The Cellular Software takes care of communication with the switching office, as well call set-up, maintenance and termination.

Communication control

M2BUS is used to communicate with external devices. This interface is also used for testing, service and maintenance purposes.

User Interface (UI)

PWR-key, keyboard, LCD, backlight, mic, ear and alert (buzzer, vibra, led) control. Serial interface from the MAD to the LCD (common for CCONT).

Authentication

Authentication is used to prevent fraudulent usage of the cellular phone.

RF monitoring

RF temperature monitoring by VCXOTEMP, ADC in CCONT.
Received signal strength monitoring by RSSI, ADC in CCONT.
False transmission detection by TXF signal, digital IO-pin.

Power up/down and Watchdog control

When the power key is pressed, the initial reset (PURX) has happened and default regulators have powered up in the CCONT, The MCU and DSP take care of the rest of power up procedures (LCD, COBBA, RF). The MCU must regularly reset the Watchdog counter in CCONT, otherwise the power will be switched off.

Accessory monitoring

Accessory detection by EAD (XMIC/HEADSETINT), AD-converter in the CCONT. Connection (FBUS) for data transfer.

Battery and charging monitoring

The MCU reads the battery type (BTYPE), temperature (BTEMP) and voltage (VBAT) values by AD-converter in CCONT, and the phone's operation is allowed only if the values are reasonable. Charging current is controlled by writing suitable values to the PWM control in the CCONT. The MCU reads also the charger voltage (VCHAR) and the charging current values (ICHAR).

Production/after sales tests and tuning

Flash and EEPROM loading, baseband tests, RF tuning

Control of CCONT via serial bus

The MCU writes controls (regulators on/off, Watchdog reset, charge PWM control) and reads the AD-conversion values. For AD-conversions the MCU gives the clock for the CCONT (bus clock), because the only clock in the CCONT is the sleep clock, which has a too low frequency.

DSP main features

The DSP (Digital Signal Processor) is in charge of the channel and speech coding according to the IS-136 specification. The block consists of a DSP and internal ROM and RAM memory. The input clock is 9.72 MHz, and the DSP has its' own internal PLL-multiplier. Main interfaces are to the MCU, and via System Logic to the COBBA and the RF.

System Logic main features

- MCU related clocking, timing and interrupts (CTIM)
- DSP related clocking, timing and interrupts (CTID)
- DSP general IO-port
 - reset and interrupts to MCU and DSP
- interface between MCU and DSP (API)
- MCU interface to System Logic (MCUif)
- MCU controlled PWMs, general IO-port and USART for MBUS (PUP)
- Receive Modem (Rxmodem)
- Interface to Keyboard, CCONT and LCD Drivers (UIF)
- Interface to MCU memories, address lines and chip select decoding (BUSC)
- DSP interface to System Logic (DSPif)
- serial accessory interface (Acclif, DSP-UART)
- Modulation, transmit filter and serial interface to COBBA (MFI)
- Serial interface for RF synthesizer control (SCU)

Memories

The speed of FLASH and SRAM is 120 ns.

FLASH

– size 8 Mbit (512k * 16 bit), optional 4 Mbit and 16 Mbit, all made layout compatible by having additional higher address lines ready in the layout. Flash memory contains the main program code for the MCU, and the EEPROM default values.

SRAM

- size 64k * 8 bit, (Phase 1, UT4) in STSOP32 package
- or 128k/256 * 8 bit, (Phase 2, UT4RM) in STSOP32 package

EEPROM

- size 16k * 8 bit, optional 8k * 8 bit
- serial interface is used.

AUDIO-RF

The audio interface and the baseband-RF interface converters are integrated into the COBBA circuit.

Cobba main features

The codec includes the microphone and earpiece amplifier and all the necessary switches for routing. There are 2 different possibilities for routing; internal and external devices. There are also all the AD- and DA-converters for the RF interface.

The DEMO block is used for FM-demodulation in analog mode.

A slow speed DA-converter provides the automatic frequency control (AFC). In addition, there is a DA-converter for the transmitter power control (TXC).

The COBBA also passes the RFC (19.44 MHz) to MAD as COBBACLK (9.72 MHz).

The COBBA is connected to the MAD via two serial buses:

- RXTXSIO, for interfacing the RF-DACs and DEMO; and also for audio codec and general control. Signals used: COBBACLK (9.72 MHz, from COBBA), COBBACSX, COBBASD (bi-directional data) and COBBADAX (data ready flag for rx-samples).
- Codec SIO, for interfacing the audio ADCs / DACs (PCM-samples). Signals: PCMDCLK (data clock 1.08 MHz / 1.215 MHz), PCMSCLK (frame sync 8.0 kHz / 8.1 kHz), PCMTxdata and PCMRxdata.

Speech processing

The speech coding functions are performed by the DSP in the MAD and the coded speech blocks are transferred to the COBBA for digital to analog conversion, down link direction. In the up link direction the PCM coded speech blocks are read from the COBBA by the DSP.

There are two separate interfaces between the MAD and the COBBA: 2 serial buses. The first serial interface is used to transfer all the COBBA control information (both the RFI part and the audio part). The second serial interface between the MAD and COBBA includes transmit and receive data, clock and frame synchronization signals. It is used to transfer the PCM samples. The frame synchronization frequency is 8 kHz (the sample rate is in digital mode 8.0 kHz and in analog mode 8.1 kHz) which indicates the rate of the PCM samples and the clock frequency is 1 MHz. The COBBA is generating both clocks.

Alert Signal Generation

.A dynamic type buzzer is used for giving alerting tones and/or melodies as a signal of an incoming call. The buzzer is controlled with a BuzzerPWM output signal from the MAD. The low impedance buzzer is connected to an output transistor that gets the drive current from the PWM output. The alert volume can be adjusted either by changing the pulse width causing the level to change or by changing the frequency to utilize the resonance frequency range of the buzzer.

A vibra alerting device is used for giving silent signal to the user of an incoming call. The device is controlled with a VibraPWM output signal from the MAD. The vibra alert can be adjusted either by changing the pulse width or by changing the pulse frequency. The vibra device is not inside the phone, but in a special vibra battery.

PWRU

The PWRU comprises the CCONT circuit and the CHAPS circuit.

CCONT main features

The CCONT generates regulated supply voltages for the baseband and the RF. There are seven 2.8 V linear regulators for the RF, one 2.8 V regulator for baseband, one special switched output (VR1_SW), one programmable 2V output (V2V), one 3/5 V output (VSIM), one 5V output (V5V), and one 1.5 V \pm 1.5% reference voltage for RF and COBBA.

Other functions include:

- power up/down procedures and reset logic
- charging control (PWM), charger detection
- watchdog
- sleep clock (32 kHz) and control
- 8-channel AD-converter.

CHAPS main features

The CHAPS comprises the hardware for charging the battery and protecting the phone from over-voltage in the charger connector.

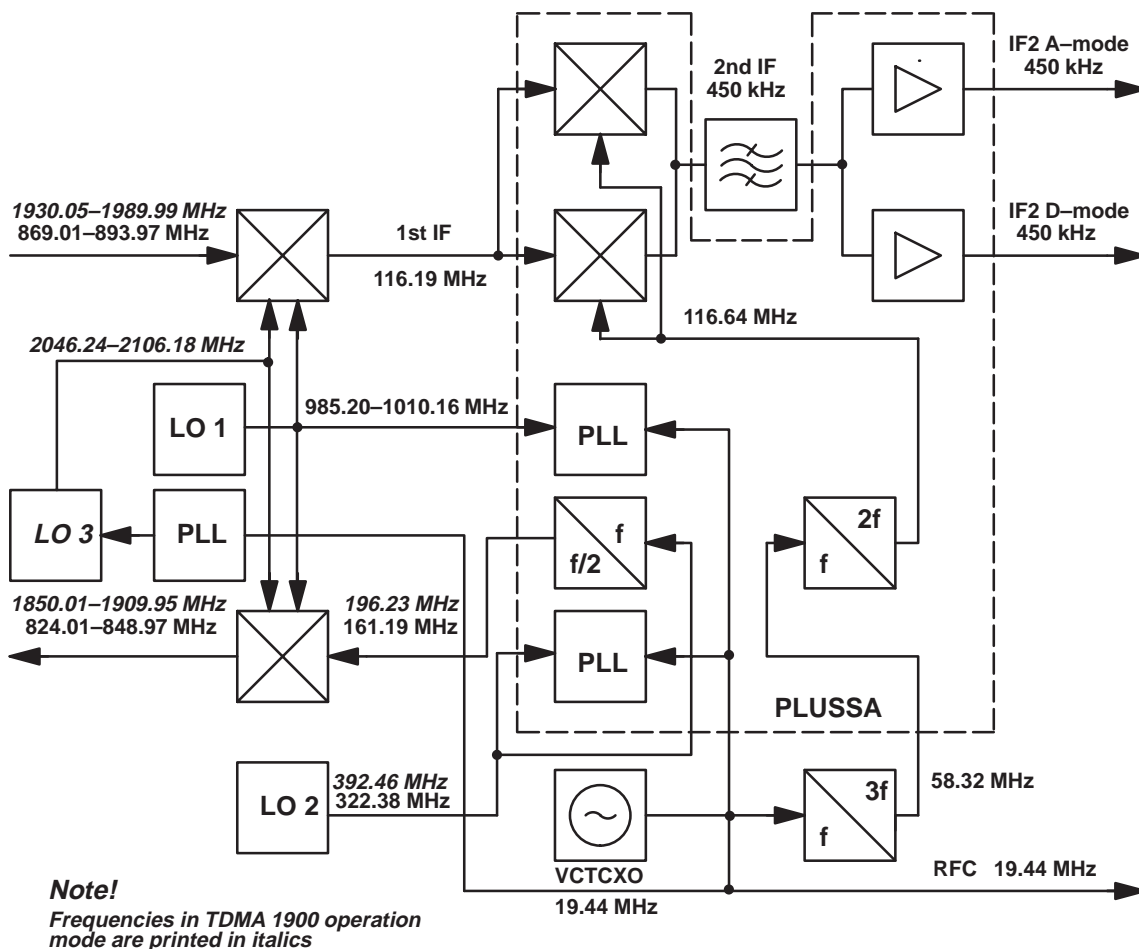
The main functions include:

- transient, over-voltage and reverse charger voltage protection
- limited start-up charge current for a totally empty battery
- voltage limit when the battery removed
- with SW protection protection against too high charging current

RF Module

RF Frequency Plan

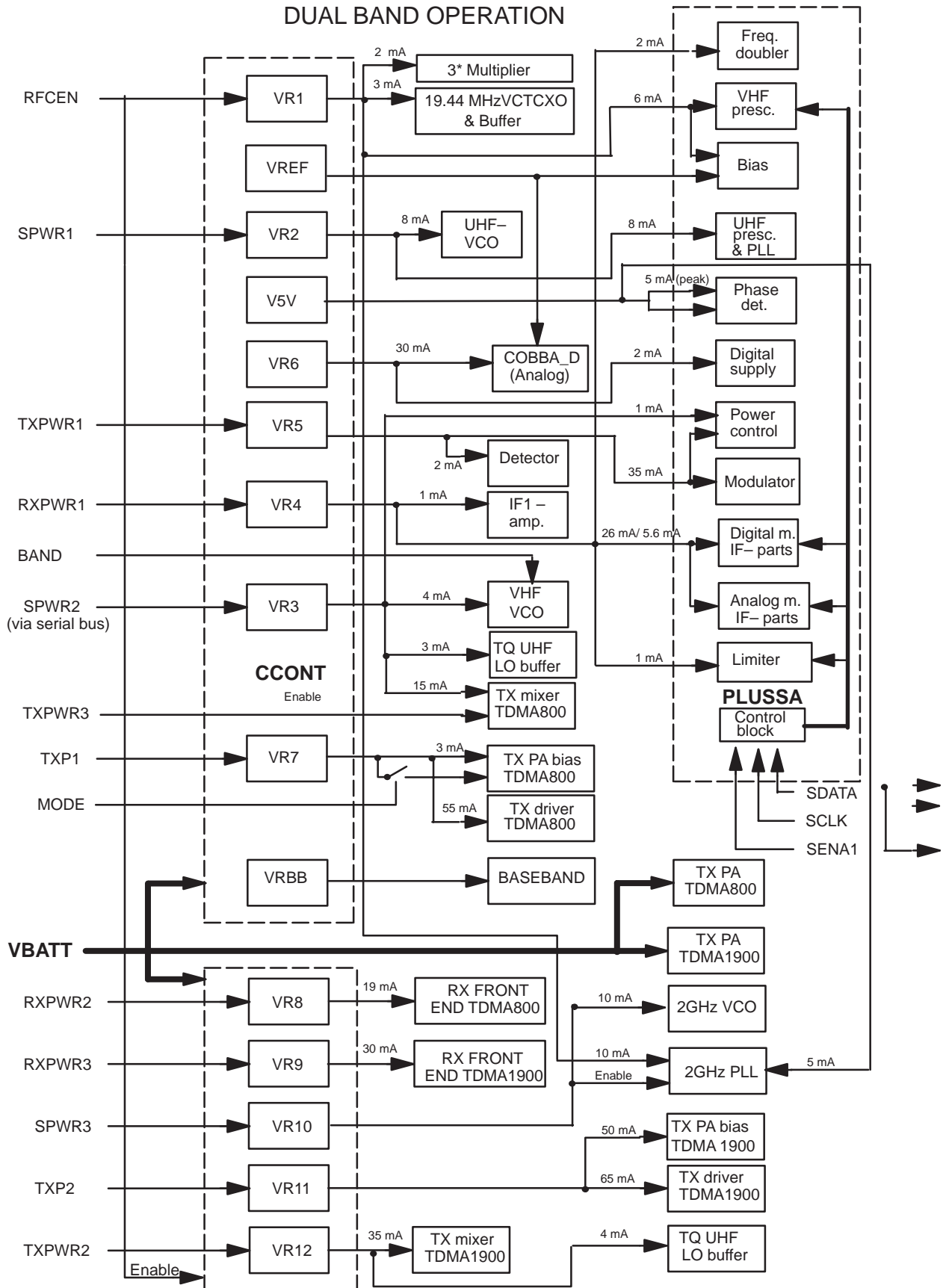
Intermediate frequencies of the RX are the same in all operation modes. The LO and modulator frequencies are different in TDMA800 and TDMA1900 operation modes. See the figure below for details.

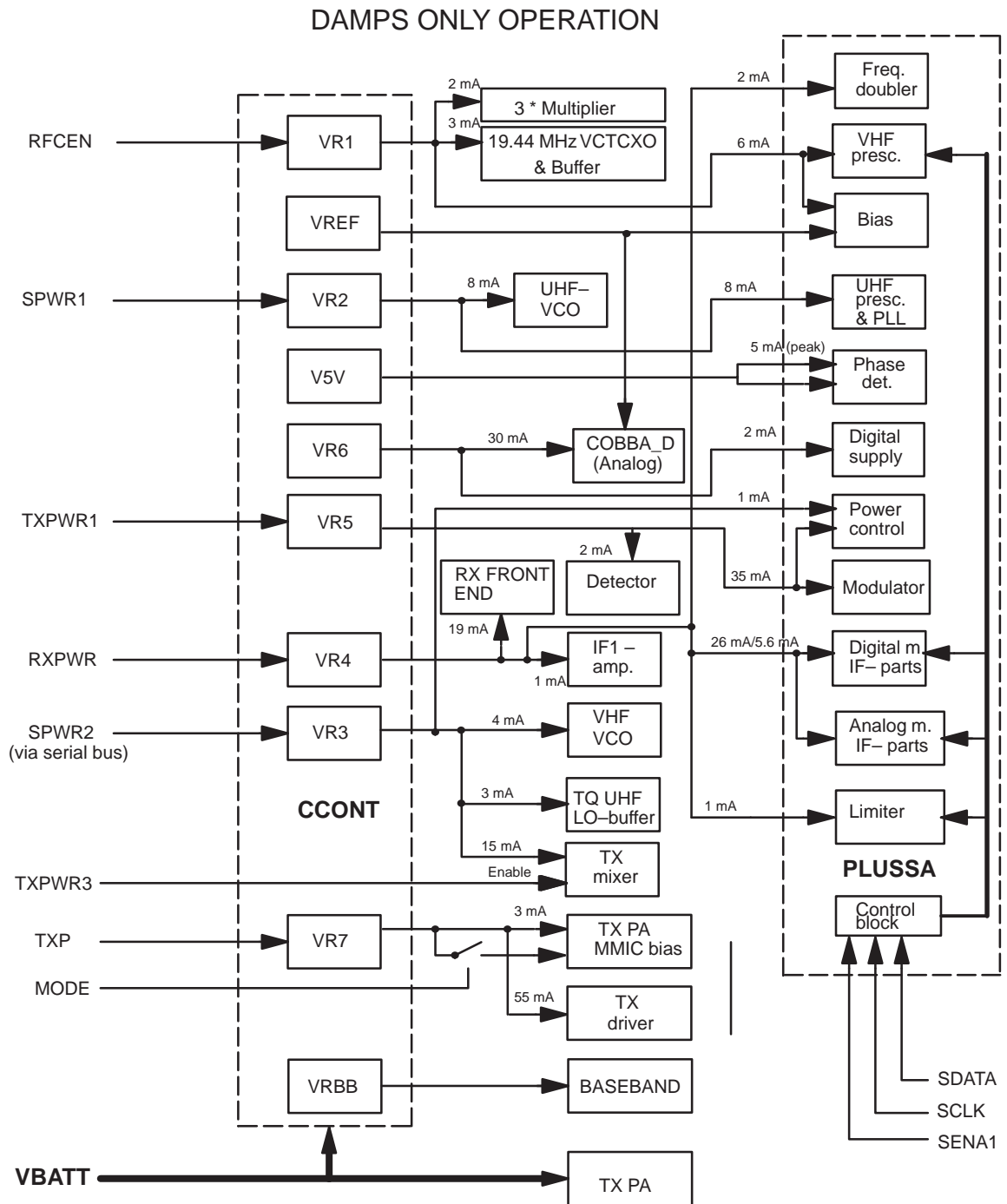


DC Characteristics

Power Distribution Diagram

There are two options for power distribution. The 1st option is a dual band phone. 2nd option is a 800 MHz DAMPS phone, which is done by removing redundant components of the 1900 MHz band operation. Current consumptions in the diagrams are only suggestive.





Power Distribution – Typical Currents (dual band)

| | 800 MHz Ext. Standby [mA] | 800 MHz Analog Control Channel [mA] | 800 MHz Analog Traffic Channel [mA] | 800 MHz Digital Control Channel [mA] | 800 MHz Digital Traffic Channel [mA] | 1900 MHz Digital Control Channel [mA] | 1900 MHz Digital Traffic Channel [mA] |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------|-------------------------------------------------|-------------------------------------------------|--------------------------------------------------|--------------------------------------------------|---------------------------------------------------|---------------------------------------------------|
| VR1 | 3.0 / 0.0 | 3.0 | 9.0 | 3.0 / 0.0 | 9.0 | 13.0 / 0.0 | 19.0 |
| VR2 | 16.0 / 0.0 | 16.0 | 16.0 | 16.0 / 0.0 | 16.0 | 0.0 | 0.0 |
| VR3 | 0.0 | 0.0 | 23.0 | 0.0 | 13.0 | 0.0 | 8.0 |
| VR4 | 11.6 / 0.0 | 11.6 | 11.6 | 32 / 0.0 | 12.8* | 32 / 0.0 | 12.8* |
| VR5 | 0.0 | 0.0 | 37.0 | 0.0 | 13.0 ** | 0.0 | 13.0 ** |
| VR6 | 2.0 / 0.1 | 2.0 | 32.0 *** | 2.0 / 0.1 | 32.0 *** | 2.0 / 0.1 | 32.0 *** |
| VR7 | 0.0 | 0.0 | 58.0 | 0.0 | 19.2 ' | 0.0 | 0.0 |
| VR8 | 19.0 / 0.0 | 19.0 | 19.0 | 19.0 / 0.0 | 7.6 '' | 0.0 | 0.0 |
| VR9 | 0.0 | 0.0 | 0.0 | 0.0 | 0.0 | 30.0 / 0.0 | 12.0 ''' |
| VR10 | 0.0 | 0.0 | 0.0 | 0.0 | 0.0 | 10.0 / 0.0 | 10.0 |
| VR11 | 0.0 | 0.0 | 0.0 | 0.0 | 0.0 | 0.0 | 38^ |
| VR12 | 0.0 | 0.0 | 0.0 | 0.0 | 0.0 | 0.0 | 12.9^^ |
| V5V | 5.0 / 0.0 | 5.0 | 5.0 | 5.0 / 0.0 | 5.0 | 5.0 / 0.0 | 5.0 |
| Total | 56.6 / 0.1 | 56.6 | 210.6 | 77.0 / 0.1 | 127.6 | 92.0 / 0.1 | 162.7 |
| NOTES: * Mean value (ON/OFF=8/20ms), peak current 32.0 mA ** Mean value (ON/OFF=7/20ms), peak current 37.0 mA *** Cobba_D mean current consumption estimated to be 30 mA ' Mean value (ON/OFF=6.6/20ms), peak current 180.0 mA '' Mean value (ON/OFF=8/20ms), peak current 10.0 mA ''' Mean value (ON/OFF=8/20ms), peak current 15.0 mA when AGC2=1 ^ Mean value (ON/OFF=6.6/20ms), peak current 115.0 mA ^^ Mean value (ON/OFF=6.6/20ms), peak current 39.0 mA | | | | | | | |

Functional Description

Receiver

DAMPS800 RX

The receiver is a double conversion receiver. Most of the RX functions are integrated in two ICs, namely receiver front end and the PLUSSA. The receiver front end contains a LNA and the 1st mixer. Analog and digital IF-parts are integrated in the PLUSSA.

The received RF signal from the antenna is fed via a duplex filter to the receiver unit. The signal is amplified by a low noise preamplifier. In the digital mode the gain of the amplifier is controlled by the AGC2 control line. The nominal gain of 17 – 19 dB is reduced in the strong signal condition about 15 dB (in the digital mode). After the preamplifier the signal is filtered by a SAW RF filter. The filter rejects spurious signals coming from the antenna and spurious emissions coming from the mixer and IF parts. The AGC2 gain step is also used to improve the receiver's performance against spurious responses in real field situations, when the received signal level is high enough for reduced gain and there are radio signals causing on channel intermodulation results.

The filtered RF-signal is down converted by an active mixer. The frequency of the first IF is 116.19 MHz. The first local signal is generated in the UHF synthesizer. The IF signal is fed to a SAW IF-filter. The filter rejects intermodulating signals and the second IF image signal. The filtered 1st IF is amplified and fed to the receiver section of the integrated RF circuit PLUSSA, which has separate IF paths for analog and digital modes of operation.

In the digital mode the IF1 signal is amplified by an AGC amplifier, which has a gain control range of 57 dB. The gain is controlled by an analog signal via AGC1-line. The amplified IF signal is down converted to the second IF in the mixer of the PLUSSA. The second local signal is the 6th overtone of the 19.44 MHz VCTCXO. The LO frequency multiplier is implemented in two stages. The first multiplication by 3 is done within the VCTCXO-module and the second multiplication by 2 is done in the PLUSSA.

The second IF frequency is 450 kHz. The second IF is filtered by a ceramic filter. The filter rejects signals of the adjacent channels. The filtered second IF is fed back to PLUSSA, where it is amplified and fed out to the COBBA_D via balanced IF2D lines.

In the analog mode the filtered and amplified IF1 signal is fed to a mixer. This mixer has been optimized for low current consumption. After this the mixer down converted signal is fed through the same IF2 filter as in digital mode and finally it is amplified in the limiter amplifier. The limited IF2 signal is fed via balanced IF2A lines to COBBA_D, which has a FM-detector.

The limiter amplifier produces also a RSSI voltage for analog mode field strength indication.

TDMA 1900 RX

On the 1900 MHz band the receiver operates only in digital mode. There is a separate front end for this band. The IF-parts are common for both bands. Operation of the receiver is similar to the digital mode operation on 800 MHz band.

Transmitter

DAMPS800 TX

The TX intermediate frequency is modulated in digital mode by an I/Q modulator contained in the transmitter section of the PLUSSA IC. The TXI and TXQ signals are generated in the COBBA_D interface circuit and they are fed differentially to the modulator. In the analog mode the FM modulation is also generated in the I/Q modulator.

The intermediate frequency level at the modulator output is controlled via a serial bus. The modulator output level control is used to tune out tolerances of the TX chain and expand the range of the VGA. The output level of the modulator is typically -18dBm on the highest power level (PL2). For lower power levels modulator output is reduced by 4 dB for each power level. In the analog mode the PLUSSA modulator has a fixed output level. All power levels are defined by adjusting the driver amplifier's gain.

The output signal from the PLUSSA modulator is filtered to reduce harmonics and RX-band noise. The final TX signal is achieved by mixing the UHF VCO signal and the modulated TX intermediate signal in an active mixer. After the mixing the TX signal is amplified by a driver stage. Driver amplifier has a gain control stage, which is used for power level adjustment and generating ramps. From driver stage the signal is fed through a TX filter to the PA MMIC.

The PA amplifies the signal TX 27–30 dB. The amplified TX signal is filtered in a duplex filter. Then signal is fed to the antenna switch, where the signal is coupled either to the antenna or to the external antenna connector. The typical maximum output level is 600 mW.

The power control loop controls the gain of the driver amplifier. The power detector consists of a directional coupler and a diode rectifier. The output voltage of the detector is compared to TXC voltage in the PLUSSA. The power control signal (TXC), comes from the RF interface circuit, the COBBA_D. The TXP signal sets driver power down to ensure off-burst level requirements.

False transmission indication is used to protect the transmitter against false transmission caused by component failure. Protection circuit is in the PLUSSA. The level for TXF is set by internal resistor values in the PLUSSA.

TDMA 1900 RX

See 800 MHz digital mode transmitter.

Frequency Synthesizers

The stable frequency reference for the synthesizers and base band circuits is the voltage controlled, temperature compensated crystal oscillator VCTCXO. The frequency of the oscillator is 19.44 MHz. It is controlled by an AFC voltage, which is generated in the base band circuits. In the digital mode operation, the receiver is locked to a base station frequency by the AFC. Next to the detector diode, there is a sensor for temperature measurement. The voltage RFTEMP from this sensor is fed to the baseband for A/D conversion. This information of the RF PA-block temperature is used as input for compensation algorithms.

The ON/OFF switching of the VCTCXO is controlled by the sleep clock in the baseband via RFCEN. Other parts of the synthesizer section are 1 GHz VCO, 2 GHz VCO, VHF VCO, PLL for 2 GHz VCO and PLL sections of the PLUSSA IC.

DAMPS800 operation

The 1GHz UHF synthesizer generates the down conversion injection for the receiver and the up conversion injection for the transmitter. The UHF frequency is 985.20 ... 1010.16 MHz, depending on the channel which is used. The 1GHz UHF VCO is a module. The PLL circuit is a dual PLL, common for both UHF and VHF synthesizers. These PLLs are comprised in the PLUSSA IC.

The LO signal for the 2nd RX mixer is multiplied from the VCTCXO frequency as described above.

The VHF synthesizer is running only on digital or analog traffic channel. The 322.38 MHz signal (divided by 2 in the PLUSSA) is used as a LO signal in the I/Q modulator of the transmitter chain.

TDMA 1900 operation

The 2 GHz VCO with external PLL circuit generates a 2046.24 ... 2106.18 MHz injection signals for 1st RX mixer and TX upconverter.

The VHF synthesizer is running only on a digital traffic channel. Operating frequency 392.46 MHz is fed to the PLUSSA modulator, where it is divided by 2 and used as the modulator LO signal.

Supply voltages in different modes of operation

| | 800 MHz Ext. Stadby | 800 MHz Analog Control Channel | 800 MHz Analog Traffic Channel | 800 MHz Digital Control Channel | 800 MHz Digital Traffic Channel | 1900 MHz Digital Control Channel | 1900 MHz Digital Traffic Channel |
|------|---------------------|--------------------------------|--------------------------------|---------------------------------|---------------------------------|----------------------------------|----------------------------------|
| VR1 | ON/OFF | ON | ON | ON/OFF | ON | ON/OFF | ON |
| VR2 | ON/OFF | ON | ON | ON/OFF | ON | ON/OFF* | ON/OFF* |
| VR3 | OFF | OFF | ON | OFF | ON | OFF | OFF |
| VR4 | ON/OFF | ON | ON | ON/OFF | ON/OFF | ON/OFF | ON/OFF |
| VR5 | OFF | OFF | ON | OFF | ON/OFF | OFF | ON/OFF |
| VR6 | ON | ON/OFF | ON | ON/OFF | ON | ON/OFF | ON |
| VR7 | OFF | OFF | ON | OFF | ON/OFF | OFF | OFF |
| VR8 | ON/OFF | ON | ON | ON/OFF | ON/OFF | OFF | OFF |
| VR9 | OFF | OFF | OFF | OFF | OFF | ON/OFF | ON/OFF |
| VR10 | OFF | OFF | OFF | ON/OFF* | ON/OFF* | ON | ON |
| VR11 | OFF | OFF | OFF | OFF | OFF | OFF | ON/OFF |
| VR12 | OFF | OFF | OFF | OFF | OFF | OFF | ON/OFF |
| VSIM | ON/OFF | ON | ON | ON/OFF | ON | ON/OFF | ON |

NOTE: * ON during interband MAHO

Software Compensations

Power Levels (TxC) vs. Temperature

It is necessary to compensate the effect of temperature on the phone output power. To monitor this environment change, the temperature measurement is done by using a NTC resistor. A factor table is used for temperature compensation. The table contains common values for all power levels and operating modes. The table values are defined without factory measurements. The temperature is measured and right compensation value is added to the TxC-value. The requirement for compensation update is for every 1 minute or after every 5 degrees C of temperature change. This means, that during analog mode transmission there will be a need for temperature reading and TxC compensation update. Because of poor cooling of RF block and insufficient linearity in high temperatures, the output power is reduced from level 2 to level 2.5 when temperature inside the phone is above +55 C in analog mode and above +60 C in digital mode.

Power Levels (TxC) vs. Channel

The duplexer frequency response ripple is compensated by the software. The power levels are calibrated on four channels. The values for chan-

nels between these tuned channels are calculated by using linear interpolation.

Power levels vs. Battery Voltage

For saving battery capacity and because of insufficient linearity in digital mode, output power is decreased from level 2 to level 2.5, when battery voltage drops below 3.3V. (tbd.). The power reduction is done linearly as a function of battery voltage V_{cc} 3.3V ... 3.1V → PL2 ... PL2.5.

TX Power Up/Down Ramps

The transmitter output power up/down ramps are controlled by the SW. A special ramp table is used for that. Requirement is for nine different ramps in digital mode for both operating bands and one ramp for analog mode. Separate ramps are used in power up and power down ramps.

Modulator Output Level

For optimum linearity and efficiency the output level of the modulator is adjusted in the production. The AGC amplifier is used as 2 dB step attenuator to define power levels. The 0 dB level is the production tuned reference level.

Digital Mode RSSI

Digital mode RSSI vs. input signal is calibrated in production, but RSSI vs. temperature and RSSI vs. channel are compensated by software.

RF Block Specifications

Receiver

DAMPS 800 Mhz Front End

| Parameter | Minimum | Typical / Nominal | Maximum | Unit / Notes |
|---------------------------------------------------------------------------------|---------|-------------------|---------|--------------|
| Gain, LNA gain enabled (gain variations vs temp. included) | 19 | 21 | 23 | dB |
| Gain, LNA gain disabled | | -10 | | dB |
| Gain step | | 15 | | dB |
| Gain variation vs temp -30...+85 °C, amplifier enabled, ref. to nominal gain | | | ±1.5 | dB |
| Noise figure, LNA enabled | | 2.5 | 3.0 | dB |

TDMA 1900 Mhz Front End

| Parameter | Minimum | Typical / Nominal | Maximum | Unit / Notes |
|---------------------------------------------------------------------------------|---------|-------------------|---------|--------------|
| Gain, LNA gain enabled (gain variations vs temp. included) | 19 | 21 | 23 | dB |
| Gain, LNA gain disabled | | -10 | | dB |
| Gain step | | 15 | | dB |
| Gain variation vs temp -30...+85 °C, amplifier enabled, ref. to nominal gain | | | ±1.5 | dB |
| Noise figure, LNA enabled | | 2.5 | 3.0 | dB |

First IF Filter

| Parameter | Minimum | Typical / Nominal | Maximum | Unit / Notes |
|---------------------|---------|-------------------|---------|--------------------------|
| Operation frequency | | 116.19 | | MHz |
| Supply voltage | 2.7 | 2.8 | 2.9 | V |
| Current consumption | | 1.0 | 1.5 | mA |
| Insertion gain | 10 | | 14 | dB |
| Noise figure | | | 3 | dB |
| IIP3 | -20 | | | dBm |
| Input impedance | | TBD | | matched to the IF filter |
| Output impedance | | TBD | | matched to PLUSSA |

Transmitter

RF Characteristics

| Item | DAMPS | TDMA1900 |
|--------------------------------------|-----------------------------|---------------------------|
| TX frequency range | 824.01...848.97 MHz | 1850.01...1909.95 MHz |
| Type | Upconversion | |
| Intermediate frequency | 161.19 MHz | 196.23 MHz |
| Nominal power on highest power level | 0.6 W (\approx 27.8 dBm) | 0.4 W (\approx 26 dBm) |
| Power control range | 30+38 dB | |
| Maximum rms error vector | 12.5 % | |

Power Levels

| Power level | Analog mode | Digital mode 800 MHz | Digital mode 1900 MHz | Design target | Unit / Notes |
|--------------------|------------------------|------------------------|------------------------|----------------------|--------------|
| | Class III | Class IV | Class IV | Class IV | dBm |
| 2 Reduced 2 (*) | 27 +2, -4 26 +2, -2 | 28 +2, -4 26 +2, -2 | 26 +2, -4 25 +2, -2 | +0.5, -1 +0.5, -1 | dBm |
| 3 | 24 +2, -4 | 24 +2, -4 | 24 +2, -4 | +2, -2 | dBm |
| 4 | 20 +2, -4 | 20 +2, -4 | 20 +2, -4 | +2, -2 | dBm |
| 5 | 16 +2, -4 | 16 +2, -4 | 16 +2, -4 | +2, -2 | dBm |
| 6 | 12 +2, -4 | 12 +2, -4 | 12 +2, -4 | +2, -2 | dBm |
| 7 | 8 +2, -4 | 8 +2, -4 | 8 +2, -4 | +2, -2 | dBm |
| 8 | - | 4 +2, -6 | 4 +2, -6 | +2, -2 | dBm |
| 9 | - | 0 +2, -6 | 0 +2, -6 | +2, -2 | dBm |
| 10 | - | -4 +2, -6 | -4 +2, -6 | +2, -2 | dBm |

(* Used when battery voltage goes lower than 3.3V and in high temperature.)

Synthesizers

UHF

| Parameter | UHF 800MHz analog mode rx/tx injection | UHF 800MHz digital mode rx/tx slot | UHF 1900MHz rx/tx slot | Unit / Notes |
|--------------------------------------|----------------------------------------|------------------------------------|------------------------|--------------|
| Frequency range | 985.20 ... 1010.16 | 985.20 ... 1010.16 | 2046.24 ... 2106.18 | MHz |
| Reference frequency | 30 | 30 | 30 | kHz |
| Reference peaks @ 30 kHz @ 60 kHz | -31 -70 | -38 -57 | -38 -57 | dBc, max |

| Parameter | UHF 800MHz analog mode rx/tx injection | UHF 800MHz digital mode rx/tx slot | UHF 1900MHz rx/tx slot | Unit / Notes |
|---------------------------------------------------------------------|----------------------------------------------|------------------------------------------|------------------------------|------------------------------|
| 2 x fo level | -20 | -20 | -20 | dBc |
| Phase noise, fo \pm 60 kHz fo \pm 120 kHz | -115 | -101 -121 | -101 -121 | dBc/Hz, max |
| Phase error | - | 4 | 4 | \circ _{rms} , max |
| Residual FM Filters: 300 Hz HP 3 kHz LP | 150 | - | - | Hz, max |
| Frequency settling time within \pm 3 kHz within \pm 30 Hz | 20 | 1.4 2.0 | 1.4 2.0 | ms, max |
| Start up settling time | 30 | 3 | 3 | ms, max |

VHF

| Parameter | VHF, 800MHz analog mode tx injection | VHF, 800MHz digital mode rx/tx slot | VHF, 1900MHz -mode tx injection | Unit / Notes |
|---------------------------------------------------------------------|--------------------------------------------|-------------------------------------------|------------------------------------------|------------------------------|
| Frequency range | 322.38 | 322.38 | 392.46 | MHz |
| Reference frequency | 30 | 30 | 30 | kHz |
| Reference peaks @ 30 kHz @ 60 kHz | -31 -66 | -41 -60 | -41 -60 | dBc, max |
| 2 x fo level | -30 | -30 | -30 | dBc |
| Phase noise, fo \pm 60 kHz fo \pm 120 kHz | -105 | -105 | -105 | dBc/Hz, max |
| Phase error | 2 | 2 | 2 | \circ _{rms} , max |
| Frequency settling time within \pm 3 kHz within \pm 30 Hz | 20 | 20 | 20 | ms, max |
| Start up settling time | 20 | 20 | 20 | ms, max |

Output Levels

| Parameter | Minimum | Typical / Nominal | Maximum | Unit / Notes |
|----------------------------------------------------------------------------------------------------------------------------------|------------------|-------------------|---------|--------------------------------------------------|
| 2G UHF synthesizer to Lo buffer level resistive load parallel capacitance | | tbd tbd | -10 | dBm Ω pF |
| 1G UHF synthesizer to TX mixer level impedance | | tbd | -5 | dBm Ω |
| VHF synthesizer to PLUSSA level resistive load parallel capacitance | 100 1k | tbd | | mV _{pp} Ω pF |
| VCTCXO 19.44 MHz to BB level resistive load parallel capacitance | 1000 10k | | 10 | mV _{pp} Ω pF |
| VCTCXO 19.44 MHz to PLUSSA level resistive load parallel capacitance | 100 | tbd tbd | | mV _{pp} Ω pF |
| VCTCXO 58.32 MHz to PLUSSA 3 * fo level fo and 2xfo level harmonic supression resistive load parallel capacitance | 50 -25 -25 | 5k tbd | 100 | mV _{pp} dBc dBc Ω pF |

Connections

RF-Baseband signals

| Signal name | From/Control | To | Parameter | Min | Typ | Max | Unit | Function |
|-------------|-----------------------------------------|--------------------------------------|--------------------|-------|------|-------|------|----------------------------------------------------------------------------|
| VBAT | battery | RF 2V8 regul., PA | Voltage | 3.1 | 3.6 | 5.3 | V | Supply voltage for discrete 2V8 regulators in dual band phone and PA |
| | | | Voltage during TX | 3.0 | 3.6 | 5.0 | V | |
| | | | Current | | | 1200 | mA | |
| VREF | CCONT | PLUSA | Voltage | 1.478 | 1.50 | 1.523 | V | PLUSA reference voltage |
| | | | Current | | | 10 | uA | |
| VR1 | CCONT / RFCEN | PLUSA, VCTCXO, 2GHz PLL | Voltage | 2.7 | 2.8 | 2.85 | V | Supply for VCTCXO & multiplier, PLUSA VHF prescaler and bias and 2 GHz PLL |
| | | | Current, tdma 800 | 3.0 | 7 | 9 | mA | |
| | | | Current, tdma1900 | 3.0 | 17 | 19 | mA | |
| VR2 | CCONT / SPWR1 | PLUSA, UHF VCO1 | Voltage | 2.7 | 2.8 | 2.85 | V | Supply voltage for tdma 800 UHF VCO and prescaler |
| | | | Current, tdma800 | 14 | 16 | 20 | mA | |
| | | | Current, tdma1900 | | off | | mA | |
| VR3 | CCONT / SPWR2 (via serial bus) | VHF- VCO, LO-buff, TX mixer | Voltage | 2.7 | 2.8 | 2.85 | V | Supply for VHF VCO, LO buffer, tdma800 TX mixer and TXF |
| | | | Current, tdma800 | 20 | 24 | 30 | mA | |
| | | | Current, tdma1900 | 4 | 9 | 12 | mA | |
| VR4 | CCONT / RXPWR1 | PLUSA, VCTCXO IF1-amp | Voltage | 2.7 | 2.8 | 2.85 | V | Supply for PLUSA IF-parts, IF1-amp. |
| | | | Current, anal.RX | 10 | 12 | 15 | mA | |
| | | | Current, digi.RX | 30 | 32 | 34 | mA | |
| VR5 | CCONT / TXPWR1 | PLUSA, TX pwr control | Voltage | 2.7 | 2.8 | 2.85 | V | Supply for PLUSA modulator, TX pwr control |
| | | | Current, TX-mode | 33 | 37 | 41 | mA | |
| VR6 | CCONT | PLUSA disc.PLL Cobba_D | Voltage | 2.7 | 2.8 | 2.85 | V | PLUSA & disc PLL: digital supply, Cobba_D: analog supply |
| | | | Current (RF block) | | 2.0 | 3.0 | mA | |
| VR7 | CCONT TXP1 | TX PA | Voltage | 2.7 | 2.8 | 2.85 | V | TX PA and driver supply |
| | | | Current, tdma800 | | 55 | 60 | mA | |
| VR7_bias | CCONT TXP1 & MODE | TX PA | Voltage | 2.7 | 2.8 | 2.85 | V | TX PA bias 800 band |
| | | | Current, tdma800 | | 3 | | mA | |
| V5V | CCONT / RFCEN | PLUSA | Voltage | 4.8 | 5.0 | 5.2 | V | PLUSA and discrete synthesizer phase det |
| | | | Current | | 3.0 | 5.0 | mA | |
| RFTEMP | RF | CCONT | Voltage | 0 | | 1.5 | V | RF temperature sensor (47 k NTC to GND) |

| Signal name | From/Control | To | Parameter | Min | Typ | Max | Unit | Function |
|-----------------|----------------------------------|-----------------------------------------------|---------------------------|------|-----|------|------------------|------------------------------------------------------------------------------------------------------|
| AFC | Cobba_D | VCTCXO | Voltage Min | 0.05 | 1.2 | 2.25 | V | Automatic frequency control signal for VCTCXO. When DAC is switched OFF AFC output is in high-Z mode |
| | | | Resolution | | 11 | | bits | |
| | | | Load resistance (dynamic) | | 10 | | k Ω | |
| | | | Load resistance (DC) | | 110 | | k Ω | |
| AGC1 | Cobba_D | PLUSA | Voltage Min | 0.5 | | 1.40 | V | Digital mode receiver gain control. DSP |
| | | | Load resistance | 10 | | | k Ω | |
| | | | Load capacitance | | | 10 | pF | |
| | | | Resolution | | 10 | | bits | |
| | | | Timing inaccuracy | | | 8 | us | |
| AGC2 | MAD (CTID AGC2, genpio) | RX LNA | Logic high "1" | 2.0 | | | V | LNA gain switch. Polarity: 0=reduced 1=normal DSP |
| | | | Logic low "0" | | | 0.7 | V | |
| | | | Sink/source curr. | | | 20 | uA | |
| | | | Load capacitance | | | 10 | pF | |
| | | | Timing inaccuracy | | | 8 | us | |
| BAND 1) | Cobba_D | VHF VCO | Logic high "1" | 2.1 | | | V | TDMA1900 operation |
| | | | Logic low "0" | 0 | | 0.4 | V | TDMA800 operation |
| | | | Sink/source curr. | | | 1.0 | mA | DSP, MCU |
| | | | Load capacitance | | | 10 | pF | |
| | | | Timing inaccuracy | | | 1 | ms | |
| MODE | MAD | Analog/ digital mode PA bias control | Logic high "1" | 2.1 | | | V | Digital 800 operation |
| | | | Logic low "0" | 0 | | 0.4 | V | Analog 800 operation |
| | | | Sink/source curr. | | | 2.0 | mA | DSP |
| | | | Load capacitance | | | tbd | pF | |
| | | | Timing inaccuracy | | | | ms | |
| IF2AP/ IF2AN | PLUSA | Cobba_D | IF2 frequency | | 450 | | kHz | Differential IF2-signal from limiter to DEMO detector in Cobba_D |
| | | | Output level, | | 0.6 | | V _{pp} | |
| | | | Load resistance | 10 | | | k Ω | |
| | | | Load capacitance | | | 5 | pF | |
| IF2DP/ IF2DN | PLUSA | Cobba_D | IF2 frequency | | 450 | | kHz | Differential IF2-signal to RX A/D-converter, PGA = 0 dB |
| | | | Output level | | 170 | 1400 | mV _{pp} | |
| | | | Source imp. | | | 600 | Ω | |

| Signal name | From/Control | To | Parameter | Min | Typ | Max | Unit | Function |
|--------------|-------------------------------------|----------------------------------|-------------------|-----|-------|-----|-----------------|----------------------------------------------------|
| RFC | VCTCXO | Cobba_D | Frequency | | 19.44 | | MHz | High stability clock signal for the locig circuits |
| | | | Signal amplitude | 0.2 | | 1.0 | V _{pp} | |
| | | | Load resistance | 10 | | | kΩ | |
| | | | Load capacitance | | | 5 | pF | |
| RFCEN | MAD (CTID, RFCEN) | CCONT, Cobba_D | Logic high "1" | 2.0 | | | V | Supply voltage VR1 ON, RFC enable |
| | | | Logic low "0" | | | 0.5 | V | Supply voltage VR1 OFF, RFC disable |
| | | | Current | | | 100 | μA | MCU, DSP |
| | | | timing inaccuracy | | | 50 | us | |
| RSSI | PLUSA | CCONT | Voltage | 0.1 | | 1.5 | V | Analog mode field strength indicator voltage |
| | | | Load resistance | 1 | | | MΩ | |
| | | | Load capacitance | | | 50 | pF | Digital mode |
| | | | Voltage | | | 0.1 | V | |
| RXPWR1 | MAD (CTID, LNA SEL) | CCONT | Logic high "1" | 2.0 | | | V | Supply voltage VR4 ON |
| | | | Logic low "0" | | | 0.5 | V | Supply voltage VR4 OFF |
| | | | Current | | | 100 | μA | DSP |
| | | | timing inaccuracy | | | 30 | us | |
| RXPWR2 1) | MAD (CTID, DSP FTC) MUX | RF block 2V8 regulator | Logic high "1" | 2.0 | | | V | Supply voltage VR8 ON |
| | | | Logic low "0" | | | 0.5 | V | Supply voltage VR8 OFF |
| | | | Current | | | 100 | μA | DSP |
| | | | timing inaccuracy | | | 30 | us | |
| RXPWR3 1) | MAD (CTID, DSP FTC) MUX | RF block 2V8 regulator | Logic high "1" | 2.0 | | | V | Supply voltage VR9 ON |
| | | | Logic low "0" | | | 0.5 | V | Supply voltage VR9 OFF |
| | | | Current | | | 100 | μA | DSP |
| | | | timing inaccuracy | | | 30 | us | |
| SCLK | MAD (SCU, SCLK) | PLUSA, UHF PLL tdma1900 | Logic high "1" | 2 | | | V | Synthesizer and control clock |
| | | | Logic low "0" | | | 0.8 | V | |
| | | | Load resistance | 50 | | | kΩ | |
| | | | Load capacitance | | | 20 | pF | |
| | | | Data rate freq. | | 1.62 | | MHz | |

| Signal name | From/Control | To | Parameter | Min | Typ | Max | Unit | Function |
|-------------|------------------------|----------------------------------|---------------------------------------|-----|-----|-----|------|---------------------------------------------------|
| SDATA | MAD (SCU, SDATA) | PLUSA, UHF PLL tdma1900 | Logic high "1" | 2.0 | | | V | Synthesizer and control data |
| | | | Logic low "0" | | | 0.8 | V | |
| | | | Load resistance | 50 | | | kΩ | |
| | | | Load capacitance | | | 20 | pF | |
| | | | Timing accuracy | | | 20 | us | |
| SENA1 | MAD (SCU, SENA1) | PLUSA | Logic high "1" | 2.0 | | | V | Synthesizer and PLUSA control enable |
| | | | Logic low "0" | | | 0.8 | V | |
| | | | Load resistance | 50 | | | kΩ | |
| | | | Load capacitance | | | 20 | pF | |
| SENA2 1) | MAD (SCU, SENA2) | UHF PLL tdma1900 | Logic high "1" | 2.0 | | | V | TDMA1900 UHF synthesizer enable |
| | | | Logic low "0" | | | 0.8 | V | |
| | | | Load resistance | 50 | | | kΩ | |
| | | | Load capacitance | | | 20 | pF | |
| SPWR1 | Cobba_D | CCONT | Logic high "1" | 2.0 | | | V | Supply voltage VR2 ON |
| | | | Logic low "0" | | | 0.5 | V | Supply voltage VR2 OFF |
| | | | Current | | | 100 | uA | DSP |
| | | | timing inaccuracy | | | 200 | us | |
| SPWR2 | Cobba_D | CCONT | Control sent via CCONT serial bus "1" | | | | | Supply voltage VR3 ON |
| | | | Control sent via CCONT serial bus "0" | | | | | Supply voltage VR3 OFF |
| | | | Current | | | 100 | uA | DSP |
| | | | timing inaccuracy | | | 200 | us | |
| SPWR3 1) | Cobba_D | RF 2v8 regul. | Logic high "1" | 2.0 | | | V | Supply voltage VR10 ON |
| | | | Logic low "0" | | | 0.5 | V | Supply voltage VR10 OFF |
| | | | Current | | | 100 | uA | DSP |
| | | | timing inaccuracy | | | 200 | us | |
| TXA | MAD (MFI, TXA) | PLUSA | Logic high "1" | 2.5 | | | V | Power control loop mode during tx burst |
| | | | Logic low "0" | | | 0.2 | V | Power control loop mode during ramp up/down |
| | | | Load resistance | 10 | | | kΩ | DSP |
| | | | Load capacitance | | | 20 | pF | |
| | | | Timing inaccuracy | | | 10 | us | |

| Signal name | From/Control | To | Parameter | Min | Typ | Max | Unit | Function |
|--------------------|-----------------------------------------------|-------------------------------------------------------------|--------------------------------|------|------|------|-----------------|------------------------------------------------------------------------|
| TXC | Cobba_D | PLUSA | Voltage Min value | 0.12 | 0.15 | 0.18 | V | Makes transmitter power ramps and sets transmitter power level |
| | | | Max value | 2.27 | 2.30 | 2.33 | | |
| | | | Load resistance | 10 | | | k Ω | |
| | | | Load capacitance | | | 10 | pF | |
| | | | Number of bits | | 10 | | | |
| TXF | PLUSA | MAD | Logic high "1" | 2.5 | | 3.0 | V | False transmission indicator, function controlled via PLUSA register |
| | | | Logic low "0" | 0 | | 0.5 | V | |
| | | | Load capacitance | | | 10 | pF | |
| TXIP/ TXIN | Cobba_D | PLUSA | Differential voltage swing | | | 1.18 | V _{pp} | Differential in-phase TX baseband signal for the RF modulator. |
| | | | Common mode v. (digital mode) | | 0.8 | | V | |
| | | | Load resistance (differential) | 200 | | | k Ω | |
| TXQP/ TXQN | Cobba_D | PLUSA | Differential voltage swing | | | 1.18 | V _{pp} | Differential quadrature phase TX baseband signal for the RF modulator. |
| | | | Common mode v. (digital mode) | | 0.8 | | V | |
| | | | Load resistance (differential) | 200 | | | k Ω | |
| TXLX1 | MAD (CTID, TXLX) | RF tdma800 | Logic high "1" | 2.1 | | | V | Low power level mode for power detector |
| | | | Logic low "0" | 0 | | 0.6 | V | High power level mode for power detector |
| | | | Sink/source curr. | | | 8.0 | mA | Timing tied to TXPWR1 |
| | | | Load capacitance | | | 10 | pF | |
| | | | Timing inaccuracy | | | 8 | us | DSP |
| TXLX2 1) | MAD <i>(TXLX2, DSPGen- Pio(6))</i> | RF tdma1900 | Logic high "1" | 2.1 | | | V | Low power level mode for power detector |
| | | | Logic low "0" | 0 | | 0.6 | V | High power level mode for power detector |
| | | | Sink/source curr. | | | 8.0 | mA | Timing tied to TXPWR1 |
| | | | Load capacitance | | | 10 | pF | |
| | | | Timing inaccuracy | | | 8 | us | DSP |
| TXP1 | MAD (MFI, TXP) 3) | CCONT, TX driver, TX PA, in tdma800 mode | Logic high "1" | 2.0 | | | V | Supply voltage VR7 ON |
| | | | Logic low "0" | | | 0.5 | V | Supply voltage VR7 OFF |
| | | | Current | | | 100 | uA | DSP |
| | | | Load capacitance | | | 10 | pF | |
| | | | Timing inaccuracy | | | 10 | us | |

| Signal name | From/Control | To | Parameter | Min | Typ | Max | Unit | Function |
|--------------|--------------------------------|---------------------------------------------------------------------|-------------------|-----|-----|-----|------|--------------------------------------------------------------------------------|
| TXP2 1) | MAD (MFI, TXP) 3) | Penta reg, TX driver, TX PA, in tdma1900 mode | Logic high "1" | 2.0 | | | V | Supply voltage VR11 ON |
| | | | Logic low "0" | | | 0.5 | V | Supply voltage VR11 OFF |
| | | | Current | | | 100 | uA | DSP |
| | | | Load capacitance | | | 10 | pF | |
| | | | Timing inaccuracy | | | 10 | us | |
| TXPWR1 | MAD (CTID, TXPWR1) | CCONT | Logic high "1" | 2.0 | | | V | Supply voltage VR5 ON, TX power control enable. 800 tx-mixer enable |
| | | | Logic low "0" | | | 0.5 | V | Supply voltage VR5 OFF, TX power control disable 800 tx-mixer disable |
| | | | Current | | | 50 | uA | DSP |
| | | | Timing inaccuracy | | | 8 | us | |
| TXPWR2 1) | MAD (CTID, BENA) | RF 2v8 regul. | Logic high "1" | 2.0 | | | V | Supply voltage VR12 ON |
| | | | Logic low "0" | | | 0.5 | V | Supply voltage VR12 OFF |
| | | | Current | | | 50 | uA | DSP |
| | | | Timing inaccuracy | | | 1 | us | |
| TXPWR3 | MAD (CTID, BENA) | RF 800 MHz upcon. | Logic high "1" | 2.0 | | | V | Upconv enabled |
| | | | Logic low "0" | | | 0.5 | V | Upconv disabled |
| | | | Current | | | 50 | uA | DSP |
| | | | Timing inaccuracy | | | 1 | us | |

- 1) Signal in use only in dual band engine
2) Valid from MAD80
3) Multiplexed with band signal at BB

Data Interface and Timing

The PLUSSA is programmed via a 3 wire serial bus. Control wires in the RF/BB interface are named SENA1, SDATA and SCLK.

SDAT: Serial data input

The PLUSSA programming data is applied to that pin. The data is qualified by SCLK clock.

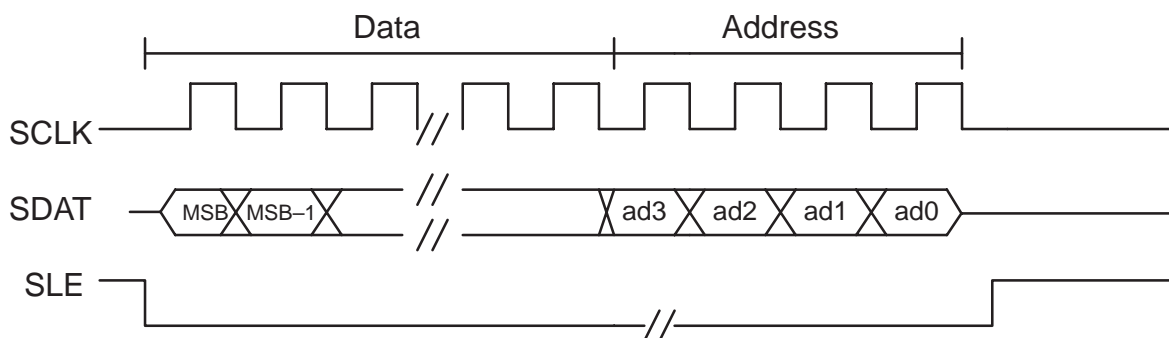
SCLK: Serial clock input

Qualifies the data applied to SDAT pin. Rising edge of the SCLK signal shifts the data to the PLUSSA's internal shift register. The falling edge after the third rising edge qualifies the internal addressing

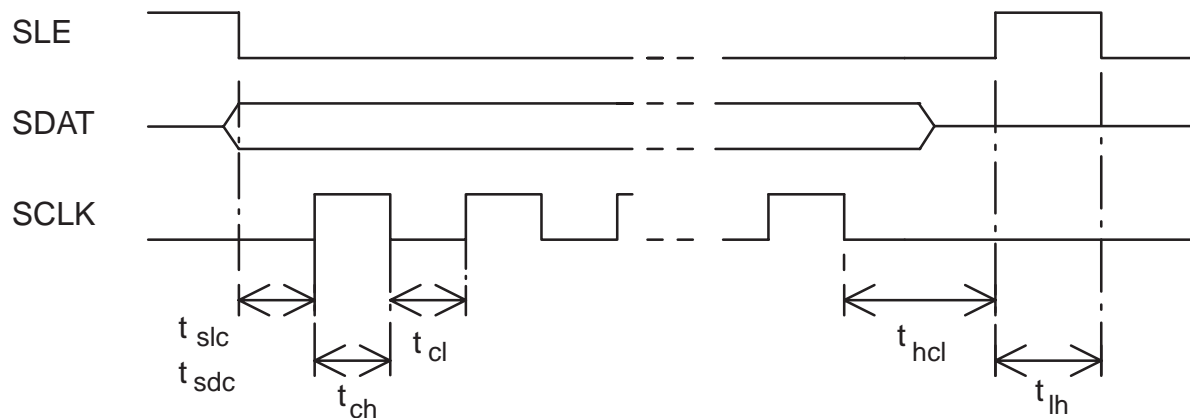
SLE: Serial latch enable (active low)

By forcing SLE line down the serial interface of the PLUSSA is activated. During the active state the PLUSSA interface accepts the clocking and the data applied to the SCLK and SDAT pins. While SLE is high the interface is completely inactive, so multiple devices can share the same SCLK and SDAT lines.

TDMA 1900 UHF Synthesizer Timing Control



Programming timing

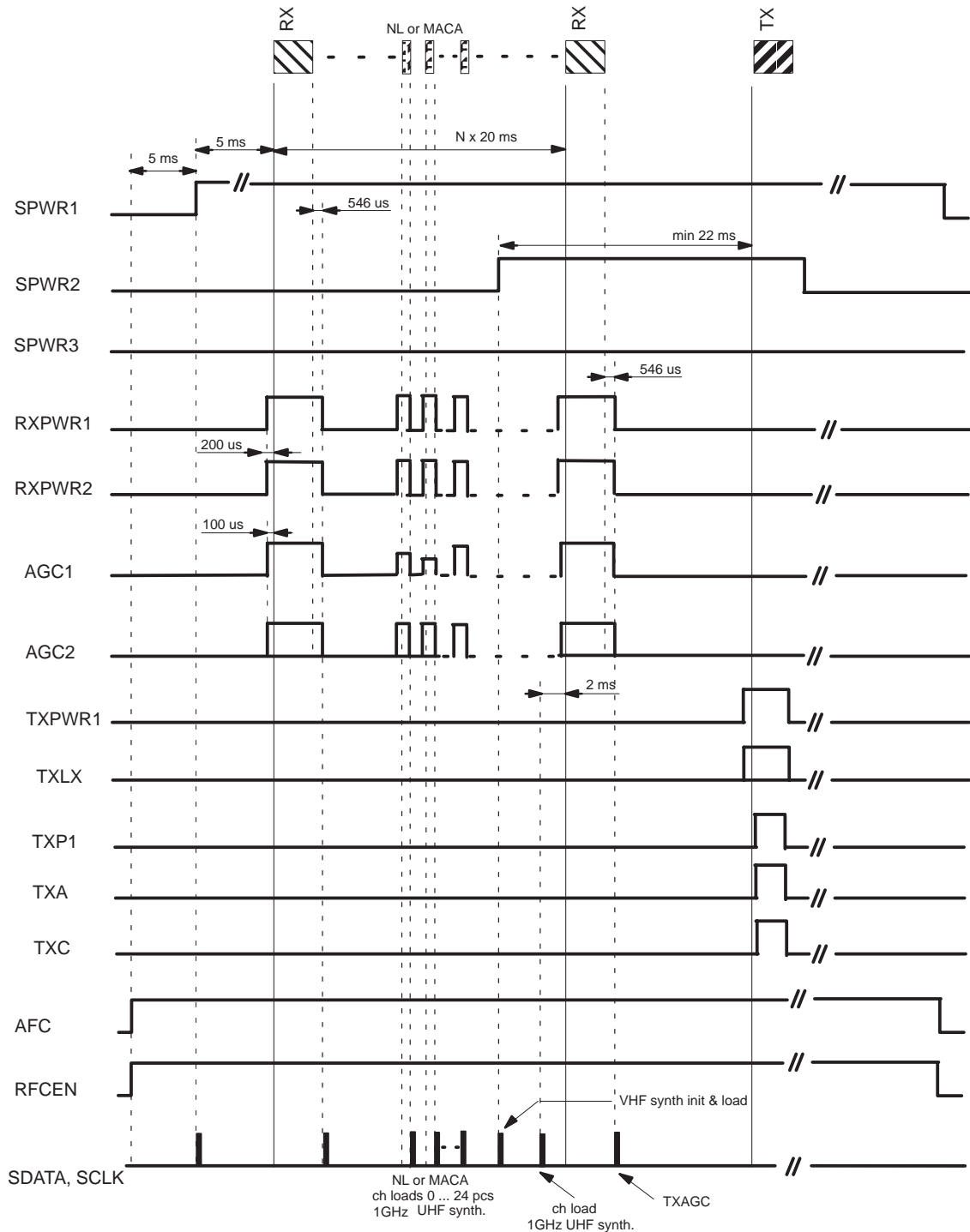


Serial data input timing

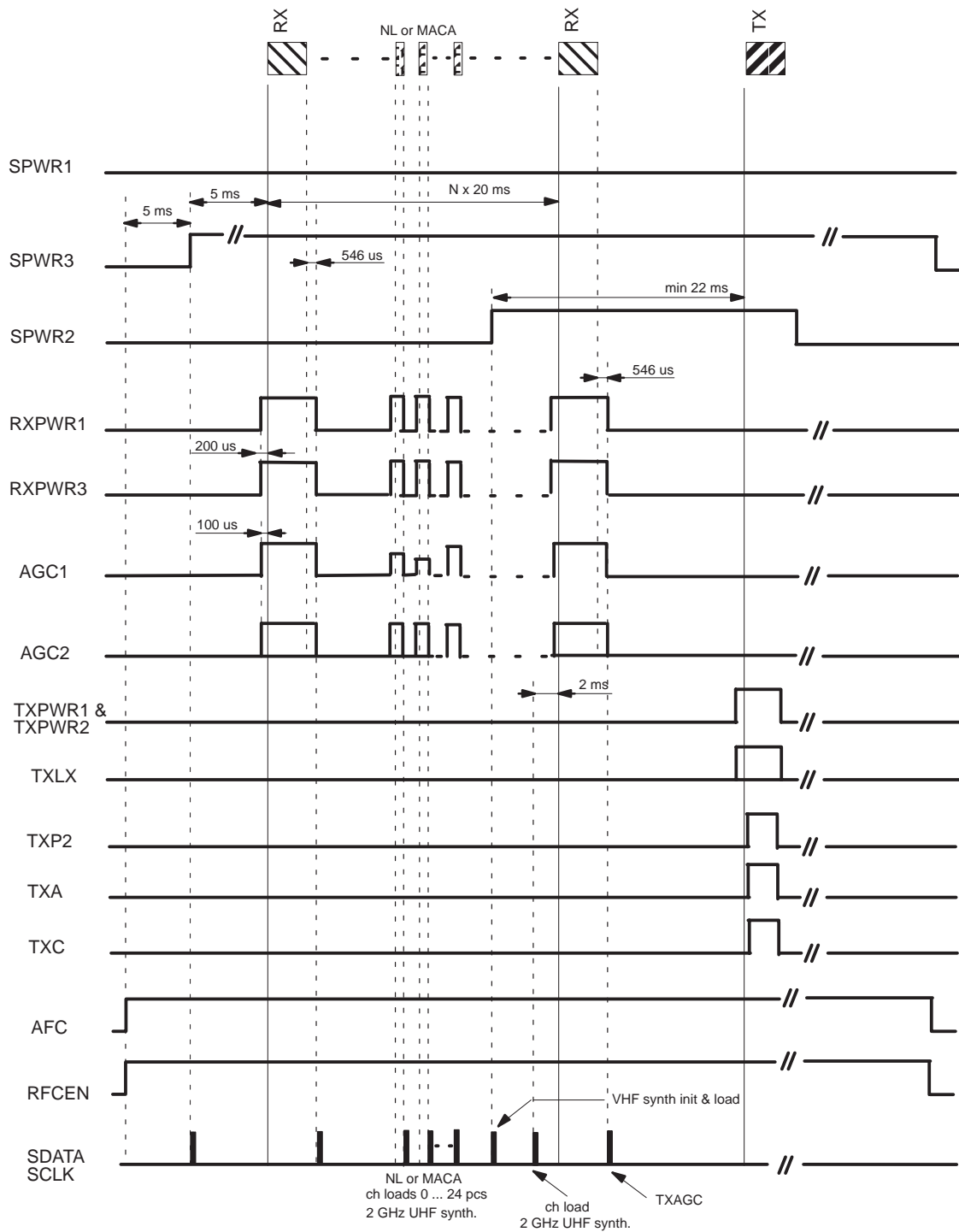
Timing ratings.

| abbr | Definition | Min [ns] | Max [ns] |
|------------------|-------------------------|----------|----------|
| t _{slc} | SLE to SCLK setup time | 40 | |
| t _{sdc} | SDAT to SCLK setup time | 20 | |
| t _{ch} | SCLK high period | 50 | |
| t _{cl} | SCLK low period | 50 | |
| t _{hcl} | SCLK to SLE hold time | 20 | |
| t _{lh} | SLE high period | 4000 | |

Digital control channels

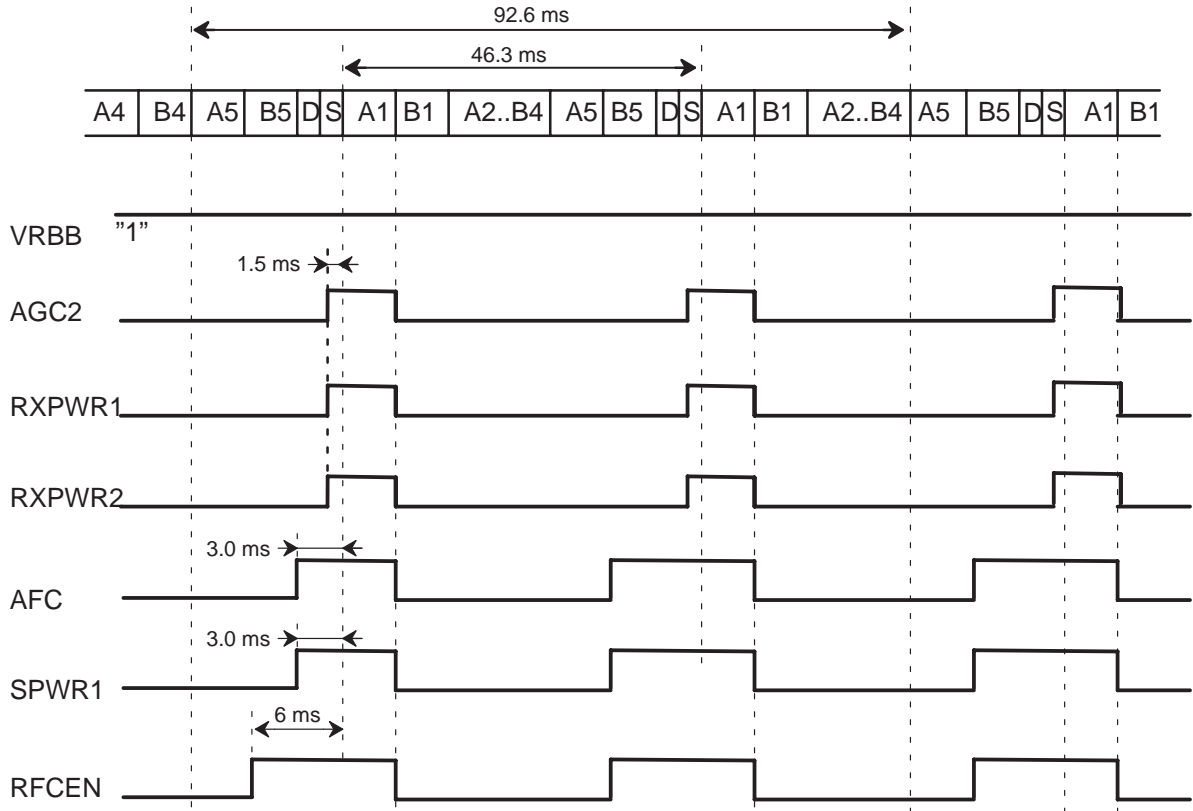


TDMA800 digital control channel timing diagram



TDMA1900 digital control channel timing diagram

Analog control channel



Extended stand by mode timings

Parts list of UT4U (Phase 1 EDMS Issue 11.3)

Code: 0200890

| ITEM | CODE | DESCRIPTION | VALUE | TYPE |
|------|---------|---------------|---------------|------------------|
| R150 | 1620019 | Res network | 0w06 2x10k j | 0404 |
| R152 | 1620025 | Res network | 0w06 2x100k j | 0404 |
| R153 | 1422881 | Chip resistor | 0.22 | 5 % 1 W 1218 |
| R154 | 1430826 | Chip resistor | 680 k | 5 % 0.063 W 0402 |
| R156 | 1430853 | Chip resistor | 2.2 M | 5 % 0.063 W 0402 |
| R158 | 1430690 | Chip jumper | | 0402 |
| R159 | 1430764 | Chip resistor | 3.3 k | 5 % 0.063 W 0402 |
| R161 | 1620025 | Res network | 0w06 2x100k j | 0404 |
| R163 | 1620019 | Res network | 0w06 2x10k j | 0404 |
| R164 | 1620019 | Res network | 0w06 2x10k j | 0404 |
| R165 | 1430796 | Chip resistor | 47 k | 5 % 0.063 W 0402 |
| R166 | 1825005 | Chip varistor | vwm14v vc30v | 0805 |
| R168 | 1430804 | Chip resistor | 100 k | 5 % 0.063 W 0402 |
| R169 | 1430690 | Chip jumper | | 0402 |
| R200 | 1620025 | Res network | 0w06 2x100k j | 0404 |
| R201 | 1620025 | Res network | 0w06 2x100k j | 0404 |
| R202 | 1620031 | Res network | 0w06 2x1k0 j | 0404 |
| R203 | 1620031 | Res network | 0w06 2x1k0 j | 0404 |
| R204 | 1620031 | Res network | 0w06 2x1k0 j | 04040 |
| R205 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R206 | 1620101 | Res network | 0w06 2x470r j | 0404 |
| R207 | 1620027 | Res network | 0w06 2x47r j | 0404 |
| R208 | 1430744 | Chip resistor | 470 | 5 % 0.063 W 0402 |
| R209 | 1430812 | Chip resistor | 220 k | 5 % 0.063 W 0402 |
| R210 | 1430770 | Chip resistor | 4.7 k | 5 % 0.063 W 0402 |
| R211 | 1620025 | Res network | 0w06 2x100k j | 0404 |
| R212 | 1430796 | Chip resistor | 47 k | 5 % 0.063 W 0402 |
| R213 | 1620027 | Res network | 0w06 2x47r j | 0404 |
| R214 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R215 | 1620031 | Res network | 0w06 2x1k0 j | 0404 |
| R216 | 1620031 | Res network | 0w06 2x1k0 j | 0404 |
| R218 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R256 | 1620025 | Res network | 0w06 2x100k j | 0404 |
| R258 | 1430718 | Chip resistor | 47 | 5 % 0.063 W 0402 |
| R259 | 1430804 | Chip resistor | 100 k | 5 % 0.063 W 0402 |
| R260 | 1620023 | Res network | 0w06 2x47k j | 0404 |
| R261 | 1430740 | Chip resistor | 330 | 5 % 0.063 W 0402 |
| R264 | 1620027 | Res network | 0w06 2x47r j | 0404 |
| R265 | 1430762 | Chip resistor | 2.2 k | 5 % 0.063 W 0402 |
| R266 | 1430762 | Chip resistor | 2.2 k | 5 % 0.063 W 0402 |
| R267 | 1430762 | Chip resistor | 2.2 k | 5 % 0.063 W 0402 |
| R268 | 1430812 | Chip resistor | 220 k | 5 % 0.063 W 0402 |
| R270 | 1430812 | Chip resistor | 220 k | 5 % 0.063 W 0402 |

System Module

Technical Documentation

| | | | | |
|------|---------|---------------|--------------|------------------|
| R271 | 1430690 | Chip jumper | | 0402 |
| R272 | 1430744 | Chip resistor | 470 | 5 % 0.063 W 0402 |
| R273 | 1430710 | Chip resistor | 22 | 5 % 0.063 W 0402 |
| R275 | 1620031 | Res network | 0w06 2x1k0 j | 0404 |
| R725 | 1430710 | Chip resistor | 22 | 5 % 0.063 W 0402 |
| R731 | 1430820 | Chip resistor | 470 k | 5 % 0.063 W 0402 |
| R741 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R742 | 1430784 | Chip resistor | 15 k | 5 % 0.063 W 0402 |
| R743 | 1430730 | Chip resistor | 150 | 5 % 0.063 W 0402 |
| R744 | 1430730 | Chip resistor | 150 | 5 % 0.063 W 0402 |
| R745 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R746 | 1430740 | Chip resistor | 330 | 5 % 0.063 W 0402 |
| R747 | 1430770 | Chip resistor | 4.7 k | 5 % 0.063 W 0402 |
| R751 | 1430812 | Chip resistor | 220 k | 5 % 0.063 W 0402 |
| R752 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R756 | 1430804 | Chip resistor | 100 k | 5 % 0.063 W 0402 |
| R758 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R759 | 1620023 | Res network | 0w06 2x47k j | 0404 |
| R760 | 1620023 | Res network | 0w06 2x47k j | 0404 |
| R761 | 1430812 | Chip resistor | 220 k | 5 % 0.063 W 0402 |
| R762 | 1430851 | Chip resistor | 15 k | 2 % 0.063 W 0402 |
| R763 | 1430758 | Chip resistor | 1.5 k | 5 % 0.063 W 0402 |
| R764 | 1430744 | Chip resistor | 470 | 5 % 0.063 W 0402 |
| R765 | 1430744 | Chip resistor | 470 | 5 % 0.063 W 0402 |
| R768 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R770 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R771 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R772 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R774 | 1430764 | Chip resistor | 3.3 k | 5 % 0.063 W 0402 |
| R775 | 1430804 | Chip resistor | 100 k | 5 % 0.063 W 0402 |
| R776 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R786 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R787 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R788 | 1430744 | Chip resistor | 470 | 5 % 0.063 W 0402 |
| R789 | 1430744 | Chip resistor | 470 | 5 % 0.063 W 0402 |
| R801 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R802 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R803 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R804 | 1430804 | Chip resistor | 100 k | 5 % 0.063 W 0402 |
| R805 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R806 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R807 | 1430762 | Chip resistor | 2.2 k | 5 % 0.063 W 0402 |
| R808 | 1430772 | Chip resistor | 5.6 k | 5 % 0.063 W 0402 |
| R809 | 1430740 | Chip resistor | 330 | 5 % 0.063 W 0402 |
| R810 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R811 | 1430788 | Chip resistor | 22 k | 5 % 0.063 W 0402 |
| R812 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |

| | | | | |
|------|---------|---------------|---------------|------------------|
| R813 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R814 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R821 | 1430710 | Chip resistor | 22 | 5 % 0.063 W 0402 |
| R822 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R823 | 1430710 | Chip resistor | 22 | 5 % 0.063 W 0402 |
| R830 | 1430792 | Chip resistor | 33 k | 5 % 0.063 W 0402 |
| R831 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R832 | 1430734 | Chip resistor | 220 | 5 % 0.063 W 0402 |
| R833 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R840 | 1430784 | Chip resistor | 15 k | 5 % 0.063 W 0402 |
| R841 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R842 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R843 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R850 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R851 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R852 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R853 | 1430784 | Chip resistor | 15 k | 5 % 0.063 W 0402 |
| R854 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R855 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R860 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R861 | 1430764 | Chip resistor | 3.3 k | 5 % 0.063 W 0402 |
| R862 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R864 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R865 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R866 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R867 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R880 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R881 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R886 | 1430772 | Chip resistor | 5.6 k | 5 % 0.063 W 0402 |
| R893 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R895 | 1430804 | Chip resistor | 100 k | 5 % 0.063 W 0402 |
| R900 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R901 | 1430710 | Chip resistor | 22 | 5 % 0.063 W 0402 |
| R904 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R905 | 1430710 | Chip resistor | 22 | 5 % 0.063 W 0402 |
| R906 | 1430718 | Chip resistor | 47 | 5 % 0.063 W 0402 |
| R907 | 1430710 | Chip resistor | 22 | 5 % 0.063 W 0402 |
| R908 | 1430734 | Chip resistor | 220 | 5 % 0.063 W 0402 |
| R910 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R930 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R931 | 1620101 | Res network | 0w06 2x470r j | 0404 |
| R933 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R934 | 1620101 | Res network | 0w06 2x470r j | 0404 |
| R936 | 1620031 | Res network | 0w06 2x1k0 j | 0404 |
| R937 | 1620029 | Res network | 0w06 2x4k7 j | 0404 |
| R938 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R939 | 1620029 | Res network | 0w06 2x4k7 j | 0404 |

System Module

Technical Documentation

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|------|---------|---------------|-------|-----------------------|
| R940 | 1800659 | NTC resistor | 47 k | 10 % 0.12 W 0805 |
| R941 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R942 | 1430788 | Chip resistor | 22 k | 5 % 0.063 W 0402 |
| R943 | 1430740 | Chip resistor | 330 | 5 % 0.063 W 0402 |
| R950 | 1430710 | Chip resistor | 22 | 5 % 0.063 W 0402 |
| R952 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R953 | 1430710 | Chip resistor | 22 | 5 % 0.063 W 0402 |
| R960 | 1430770 | Chip resistor | 4.7 k | 5 % 0.063 W 0402 |
| R961 | 1430710 | Chip resistor | 22 | 5 % 0.063 W 0402 |
| R980 | 1430740 | Chip resistor | 330 | 5 % 0.063 W 0402 |
| R981 | 1430734 | Chip resistor | 220 | 5 % 0.063 W 0402 |
| R982 | 1430710 | Chip resistor | 22 | 5 % 0.063 W 0402 |
| R983 | 1430734 | Chip resistor | 220 | 5 % 0.063 W 0402 |
| C101 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C150 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C151 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C154 | 2320548 | Ceramic cap. | 33 p | 5 % 50 V 0402 |
| C155 | 2320540 | Ceramic cap. | 15 p | 5 % 50 V 0402 |
| C157 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C158 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C159 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C160 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C161 | 2310781 | Ceramic cap. | 220 n | 10 % 16 V 0805 |
| C162 | 2310781 | Ceramic cap. | 220 n | 10 % 16 V 0805 |
| C163 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C164 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C166 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C167 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C169 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C170 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C171 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C172 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C173 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C174 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C175 | 2312403 | Ceramic cap. | 2.2 u | 10 % 10 V 1206 |
| C176 | 2312403 | Ceramic cap. | 2.2 u | 10 % 10 V 1206 |
| C177 | 2610005 | Tantalum cap. | 10 u | 20 % 16 V 3.5x2.8x1.9 |
| C178 | 2610005 | Tantalum cap. | 10 u | 20 % 16 V 3.5x2.8x1.9 |
| C179 | 2604127 | Tantalum cap. | 1.0 u | 20 % 35 V 3.5x2.8x1.9 |
| C180 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C181 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C185 | 2610005 | Tantalum cap. | 10 u | 20 % 16 V 3.5x2.8x1.9 |
| C187 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C188 | 2610005 | Tantalum cap. | 10 u | 20 % 16 V 3.5x2.8x1.9 |
| C189 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C190 | 2320508 | Ceramic cap. | 1.0 p | 0.25 % 50 V 0402 |
| C200 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |

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|------|---------|--------------|-------|----------------|
| C201 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C202 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C203 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C204 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C205 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C206 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C207 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C209 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C210 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C212 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C214 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C217 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C218 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C219 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C220 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C221 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C223 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C225 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C227 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C228 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C250 | 2320564 | Ceramic cap. | 150 p | 5 % 50 V 0402 |
| C255 | 2320564 | Ceramic cap. | 150 p | 5 % 50 V 0402 |
| C256 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C258 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C259 | 2312296 | Ceramic cap. | | Y5 V 1210 |
| C260 | 2312296 | Ceramic cap. | | Y5 V 1210 |
| C261 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C262 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C263 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C264 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C265 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C266 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C268 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C269 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C270 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C271 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C273 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C275 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C277 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C278 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C279 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C281 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C282 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C283 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C284 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C285 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C286 | 2320469 | Ceramic cap. | | Y5 V 0603 |

System Module

Technical Documentation

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|------|---------|--------------|-------|------------------|
| C701 | 2320508 | Ceramic cap. | 1.0 p | 0.25 % 50 V 0402 |
| C702 | 2320524 | Ceramic cap. | 3.3 p | 0.25 % 50 V 0402 |
| C703 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |
| C706 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |
| C707 | 2320518 | Ceramic cap. | 1.8 p | 0.25 % 50 V 0402 |
| C708 | 2320520 | Ceramic cap. | 2.2 p | 0.25 % 50 V 0402 |
| C709 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |
| C710 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C729 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C733 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C734 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C735 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C739 | 2320520 | Ceramic cap. | 2.2 p | 0.25 % 50 V 0402 |
| C741 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C743 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C744 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C745 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C746 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C747 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C748 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C755 | 2320728 | Ceramic cap. | 220 p | 10 % 50 V 0402 |
| C756 | 2320618 | Ceramic cap. | 4.7 n | 5 % 25 V 0402 |
| C757 | 2320552 | Ceramic cap. | 47 p | 5 % 50 V 0402 |
| C758 | 2320552 | Ceramic cap. | 47 p | 5 % 50 V 0402 |
| C759 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C760 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C761 | 2320618 | Ceramic cap. | 4.7 n | 5 % 25 V 0402 |
| C762 | 2320618 | Ceramic cap. | 4.7 n | 5 % 25 V 0402 |
| C763 | 2320618 | Ceramic cap. | 4.7 n | 5 % 25 V 0402 |
| C764 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C765 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C766 | 2320592 | Ceramic cap. | 2.2 n | 5 % 50 V 0402 |
| C767 | 2320618 | Ceramic cap. | 4.7 n | 5 % 25 V 0402 |
| C768 | 2320618 | Ceramic cap. | 4.7 n | 5 % 25 V 0402 |
| C769 | 2320618 | Ceramic cap. | 4.7 n | 5 % 25 V 0402 |
| C770 | 2320618 | Ceramic cap. | 4.7 n | 5 % 25 V 0402 |
| C773 | 2320618 | Ceramic cap. | 4.7 n | 5 % 25 V 0402 |
| C778 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C779 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C780 | 2320586 | Ceramic cap. | 1.2 n | 5 % 50 V 0402 |
| C781 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C782 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C783 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C784 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C785 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C786 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C787 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |

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|------|---------|---------------|-------|-----------------------|
| C788 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C789 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C790 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C791 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C792 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C793 | 2310424 | Ceramic cap. | 100 p | 5 % 50 V 0805 |
| C794 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C795 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C796 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C797 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C798 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C801 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C802 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C803 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C805 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C806 | 2320604 | Ceramic cap. | 18 p | 5 % 50 V 0402 |
| C807 | 2611668 | Tantalum cap. | 4.7 u | 20 % 10 V 3.2x1.6x1.6 |
| C808 | 2320540 | Ceramic cap. | 15 p | 5 % 50 V 0402 |
| C809 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C810 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C811 | 2320520 | Ceramic cap. | 2.2 p | 0.25 % 50 V 0402 |
| C815 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C816 | 2320508 | Ceramic cap. | 1.0 p | 0.25 % 50 V 0402 |
| C821 | 2320508 | Ceramic cap. | 1.0 p | 0.25 % 50 V 0402 |
| C824 | 2610005 | Tantalum cap. | 10 u | 20 % 16 V 3.5x2.8x1.9 |
| C825 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C830 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C831 | 2310248 | Ceramic cap. | 4.7 n | 5 % 50 V 1206 |
| C833 | 2320564 | Ceramic cap. | 150 p | 5 % 50 V 0402 |
| C834 | 2320564 | Ceramic cap. | 150 p | 5 % 50 V 0402 |
| C840 | 2320548 | Ceramic cap. | 33 p | 5 % 50 V 0402 |
| C841 | 2320728 | Ceramic cap. | 220 p | 10 % 50 V 0402 |
| C842 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C843 | 2320532 | Ceramic cap. | 6.8 p | 0.25 % 50 V 0402 |
| C844 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C845 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C850 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C851 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C853 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C854 | 2320524 | Ceramic cap. | 3.3 p | 0.25 % 50 V 0402 |
| C855 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C856 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C857 | 2320728 | Ceramic cap. | 220 p | 10 % 50 V 0402 |
| C858 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C860 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C861 | 2420017 | Ceramic cap. | 18 n | 5 % 16 V 1206 |
| C864 | 2320564 | Ceramic cap. | 150 p | 5 % 50 V 0402 |

System Module

Technical Documentation

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|------|---------|---------------|-------|-----------------------|
| C865 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C866 | 2320564 | Ceramic cap. | 150 p | 5 % 50 V 0402 |
| C867 | 2611668 | Tantalum cap. | 4.7 u | 20 % 10 V 3.2x1.6x1.6 |
| C868 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C869 | 2320522 | Ceramic cap. | 2.7 p | 0.25 % 50 V 0402 |
| C881 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C882 | 2611668 | Tantalum cap. | 4.7 u | 20 % 10 V 3.2x1.6x1.6 |
| C885 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C886 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C887 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C898 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C900 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C903 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |
| C904 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C905 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C906 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C907 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C908 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C910 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C911 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C914 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C917 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C920 | 2320917 | Ceramic cap. | | 25 V 0402 |
| C921 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |
| C923 | 2320941 | Ceramic cap. | | 10 V 0402 |
| C924 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C925 | 2320913 | Ceramic cap. | | 25 V 0402 |
| C926 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C927 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C928 | 2320508 | Ceramic cap. | 1.0 p | 0.25 % 50 V 0402 |
| C929 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |
| C930 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C931 | 2320524 | Ceramic cap. | 3.3 p | 0.25 % 50 V 0402 |
| C932 | 2320508 | Ceramic cap. | 1.0 p | 0.25 % 50 V 0402 |
| C934 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |
| C937 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |
| C938 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C939 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |
| C940 | 2320602 | Ceramic cap. | 4.7 p | 0.25 % 50 V 0402 |
| C941 | 2320508 | Ceramic cap. | 1.0 p | 0.25 % 50 V 0402 |
| C943 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |
| C950 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C951 | 2320552 | Ceramic cap. | 47 p | 5 % 50 V 0402 |
| C952 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C953 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C954 | 2320602 | Ceramic cap. | 4.7 p | 0.25 % 50 V 0402 |
| C955 | 2320508 | Ceramic cap. | 1.0 p | 0.25 % 50 V 0402 |

Technical Documentation

System Module

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|------|---------|-------------------------|----------|------------------------|
| C960 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C961 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |
| C962 | 2320552 | Ceramic cap. | 47 p | 5 % 50 V 0402 |
| C963 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C965 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C966 | 2320913 | Ceramic cap. | | 25 V 0402 |
| C967 | 2320915 | Ceramic cap. | | 25 V 0402 |
| C968 | 2320921 | Ceramic cap. | | 25 V 0402 |
| C969 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C970 | 2320931 | Ceramic cap. | | 25 V 0402 |
| C972 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C980 | 2320520 | Ceramic cap. | 2.2 p | 0.25 % 50 V 0402 |
| C981 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C982 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C983 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C990 | 2320524 | Ceramic cap. | 3.3 p | 0.25 % 50 V 0402 |
| C992 | 2320602 | Ceramic cap. | 4.7 p | 0.25 % 50 V 0402 |
| L701 | 3643045 | Chip coil | 27 n | 5 % Q=45/250 MHz 0805 |
| L702 | 3643101 | Chip coil | 270 n | 10 % Q=20/25 MHz 0805 |
| L703 | 3640051 | Chip coil | 12 n | 5 % Q=45/250 MHz 0805 |
| L705 | 3608319 | Chip coil | 270 n | 10 % 1206 |
| L721 | 3641521 | Chip coil | 6 n | 5 % Q=50/250 MHz 0805 |
| L723 | 3645157 | Chip coil | 100 n | 10 % Q=12/100 MHz 0603 |
| L724 | 3608407 | Chip coil | 470 n | 5 % 1206 |
| L741 | 3641620 | Chip coil | 180 n | 5 % Q=35/100 MHz 0805 |
| L750 | 3643067 | Chip coil | 100 u | 5 % Q=15/796 kHz 1008 |
| L801 | 3645043 | Chip coil | 47 n | 2 % Q=40/200 MHz 0805 |
| L840 | 3641620 | Chip coil | 180 n | 5 % Q=35/100 MHz 0805 |
| L841 | 3641575 | Chip coil | 100 n | 5 % Q=40/150 MHz 0805 |
| L850 | 3645045 | Chip coil | | 10 % Q=45/10 MHz 0805 |
| L901 | 3645157 | Chip coil | 100 n | 10 % Q=12/100 MHz 0603 |
| L902 | 3645005 | Chip coil | 15 n | 10 % Q=12/100 MHz 0603 |
| L903 | 3645157 | Chip coil | 100 n | 10 % Q=12/100 MHz 0603 |
| L905 | 3643069 | Chip coil | 47 n | 5 % Q=40/200 MHz 0805 |
| L906 | 3203701 | Ferrite bead 33r/100mhz | 0805 | 0805 |
| L930 | 3645157 | Chip coil | 100 n | 10 % Q=12/100 MHz 0603 |
| L931 | 3645157 | Chip coil | 100 n | 10 % Q=12/100 MHz 0603 |
| L940 | 3645001 | Chip coil | 4 n | 10 % Q=10/100 MHz 0603 |
| L950 | 3645005 | Chip coil | 15 n | 10 % Q=12/100 MHz 0603 |
| L951 | 3645117 | Chip coil | 5 n | Q=8/100M 0603 |
| L960 | 3645171 | Chip coil | 6 n | 10 % Q=10/100 MHz 0603 |
| L961 | 3645005 | Chip coil | 15 n | 10 % Q=12/100 MHz 0603 |
| L962 | 3645005 | Chip coil | 15 n | 10 % Q=12/100 MHz 0603 |
| L964 | 3643001 | Chip coil | 10 n | 5 % Q=30/250 MHz 0805 |
| L980 | 3645157 | Chip coil | 100 n | 10 % Q=12/100 MHz 0603 |
| L993 | 3640013 | Chip coil | 8 n | 5 % Q=50/250 MHz 0805 |
| B150 | 4510003 | Crystal | 32.768 k | +−20PPM 8x3.8 |

System Module

Technical Documentation

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|------|---------|---------------------------|-----------------|------------------------|-----------------------------|
| G820 | 4350121 | Vco | 985.2-1010.2mhz | 2.8v 8ma | TDMA |
| G850 | 4510165 | VCTCXO | | 19.44 M | +/-2.5PPM 2.8V |
| G860 | 4350117 | Vco | | 2046-2106mhz | 2.8v 10ma |
| F150 | 5119019 | SM, fuse | | f 1.5a 32v | 0603 |
| Z100 | 3640069 | Filt | | 47pf 25v 0r01 6a | 1206 |
| Z701 | 4510121 | Saw filter | | 881.5+-12.5 M | /3.5DB 4X4 |
| Z726 | 4550053 | Cer.filt | | 1960+-30mhz | 8.4x5.95 |
| Z741 | 4511011 | Saw filter | | 116.19+-0.015 M | 9.3X5 |
| Z750 | 4550057 | Cer.filt | | 450+-12.5khz | 11.8x7.5 |
| Z900 | 4511031 | Saw filter | | 161.2/196.2 M | 5X5 |
| Z901 | 4510127 | Saw filter | | 836.5+-12.5 M | /3.5DB 4X4 |
| Z910 | 4512013 | Dupl | | 824-849/869-894mhz | 19.2x11.2 |
| Z950 | 4550049 | Cer.filt 1 | | 880+-30mhz/4.5db | 8.4x6.2 |
| Z951 | 4511023 | Saw filter | | 1880+-30 M/4.2DB | 3X3 |
| Z960 | 4512015 | Dupl | | 1850-1910/1930-1990mhz | 19x11 |
| Z961 | 3640069 | Filt | | 47pf 25v 0r01 6a | 1206 |
| V150 | 4210037 | Transistor | | BCW30 | pnp 32 V 0.1 A SOT23 |
| V151 | 4110067 | Schottky diode | | MBR0520L | 20 V 0.5 A SOD123 |
| V152 | 4210052 | Transistor | | DTC114EE | npn RB V EM3 |
| V153 | 4211202 | DM MosFet | | p-ch | 50 V 0.13 A SOT23 |
| V200 | 4110072 | Diode x 2 | | BAV99W | 70 V 0.2 A SOT323 |
| V201 | 4110072 | Diode x 2 | | BAV99W | 70 V 0.2 A SOT323 |
| V202 | 4110072 | Diode x 2 | | BAV99W | 70 V 0.2 A SOT323 |
| V250 | 4210100 | Transistor | | BC848W | npn 30 V SOT323 |
| V741 | 4210066 | Transistor | | BFR93AW | npn 12 V 35 mA SOT323 |
| V800 | 4219903 | Transistor x 2 | | BFM505 | npn 20 V 20V18 mA SOT363 |
| V801 | 4112441 | Pin diode | | BA592 | 35 V 0.1 A SOD323 |
| V802 | 4110018 | Cap. diode | | BB135 | 30 V SOD323 |
| V803 | 4110027 | Cap. diode | | SV239 | |
| V840 | 4210066 | Transistor | | BFR93AW | npn 12 V 35 mA SOT323 |
| V850 | 4210100 | Transistor | | BC848W | npn 30 V SOT323 |
| V929 | 4110008 | Schottky diode | | HSMS2825 | 8 V SOT143 |
| V930 | 4110008 | Schottky diode | | HSMS2825 | 8 V SOT143 |
| V932 | 4112469 | Pindix2 | | bar64-07 200v 0.1a | SOT143 |
| D200 | 4340273 | IC, SRAM | | | STSOP32 |
| D201 | 4340261 | IC, flash mem. | | | TSO48 |
| D202 | 4370249 | Mad1 | | rom2 f711857 c12 | TQFP144 |
| D203 | 4340357 | IC, EEPROM | | | SO8 |
| D801 | 4340126 | IC, 1xnand 2input cmos ss | | TC7S00F | SSO5 |
| N150 | 4370047 | Ccont | | 2f dct3 bb asic | TQFP64 |
| N151 | 4370165 | Uba2006t | | chaps charg.control | SO16 |
| N250 | 4370341 | Cobba | | d b03 bb asic damp | TQFP64 |
| N701 | 4370063 | Sc3918 | | tdma rec 869-894mhz | QSOP16 |
| N702 | 4340247 | Ty40498 | | reg 2.8v | TSSOP16 |
| N721 | 4370065 | Sc3919 | | tdma rec 1930-1990 | QSOP16 |
| N750 | 4370273 | PLUSSA | | txmod+rxif+2pll | TQFP64 |

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|------|---------|-------------------------|-----------------------|--------------|
| N880 | 4340237 | IC, PLL | UMA1021M | SSOP20 |
| N900 | 4340171 | IC, upconv 1.9ghz 3v so | uPC8106T | SO6S |
| N902 | 4340277 | IC, RF amp. | FMM5020 | SSOP8 |
| N903 | 4370311 | Rf9103p1 | pw amp | 824-849 mhz |
| N950 | 4340275 | IC, RF amp. | FMM5022 | SSOP8 |
| N960 | 4370313 | Rf9111p1 | pw amp | 1850-1910mhz |
| N980 | 4340381 | Mrfic1813 | upconvgaas 1.9g | TSSOP16 |
| X100 | 5469061 | SM, system conn | 6af+3dc+mic+jack | |
| X102 | 5460021 | SM, conn | 2x14m spring p1.0 | PCB/PCB |
| X104 | 5469069 | SM, batt conn | 2pol spr p3.5 | 100V2A |
| X105 | 5469069 | SM, batt conn | 2pol spr p3.5 | 100V2A |
| X991 | 5429007 | SM, coax conn | m sw 50r | 0.4-2ghz |
| A950 | 9517018 | Shield assembly | 3m dmc01006 | HD963 |
| | 9380753 | Bar code label | dmd03311 | 27x6.5 |
| | 9850017 | PCB | UT4 163.7X135.9X0.9 6 | 2/PA |

Parts list of UT4RM (Phase 2 EDMS Issue 5.0)

Code: 0201238

| ITEM | CODE | DESCRIPTION | VALUE | TYPE |
|------|---------|---------------|---------------|------------------|
| R150 | 1620019 | Res network | 0w06 2x10k j | 0404 |
| R152 | 1620025 | Res network | 0w06 2x100k j | 0404 |
| R153 | 1422881 | Chip resistor | 0.22 | 5 % 1 W 1218 |
| R154 | 1430826 | Chip resistor | 680 k | 5 % 0.063 W 0402 |
| R156 | 1430853 | Chip resistor | 2.2 M | 5 % 0.063 W 0402 |
| R159 | 1430764 | Chip resistor | 3.3 k | 5 % 0.063 W 0402 |
| R161 | 1620025 | Res network | 0w06 2x100k j | 0404 |
| R163 | 1620019 | Res network | 0w06 2x10k j | 0404 |
| R164 | 1620019 | Res network | 0w06 2x10k j | 0404 |
| R165 | 1430796 | Chip resistor | 47 k | 5 % 0.063 W 0402 |
| R166 | 1825005 | Chip varistor | vwm14v vc30v | 0805 |
| R168 | 1430804 | Chip resistor | 100 k | 5 % 0.063 W 0402 |
| R169 | 1430690 | Chip jumper | | 0402 |
| R200 | 1620025 | Res network | 0w06 2x100k j | 0404 |
| R201 | 1620025 | Res network | 0w06 2x100k j | 0404 |
| R202 | 1620031 | Res network | 0w06 2x1k0 j | 0404 |
| R203 | 1620031 | Res network | 0w06 2x1k0 j | 0404 |
| R204 | 1620031 | Res network | 0w06 2x1k0 j | 0404 |
| R205 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R206 | 1620101 | Res network | 0w06 2x470r j | 0404 |
| R207 | 1620027 | Res network | 0w06 2x47r j | 0404 |
| R208 | 1430744 | Chip resistor | 470 | 5 % 0.063 W 0402 |
| R209 | 1430812 | Chip resistor | 220 k | 5 % 0.063 W 0402 |
| R210 | 1430770 | Chip resistor | 4.7 k | 5 % 0.063 W 0402 |
| R211 | 1620025 | Res network | 0w06 2x100k j | 0404 |
| R212 | 1430796 | Chip resistor | 47 k | 5 % 0.063 W 0402 |
| R213 | 1620027 | Res network | 0w06 2x47r j | 0404 |
| R214 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R215 | 1620031 | Res network | 0w06 2x1k0 j | 0404 |
| R216 | 1620031 | Res network | 0w06 2x1k0 j | 0404 |
| R218 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R252 | 1430804 | Chip resistor | 100 k | 5 % 0.063 W 0402 |
| R256 | 1620025 | Res network | 0w06 2x100k j | 0404 |
| R257 | 1430690 | Chip jumper | | 0402 |
| R258 | 1430718 | Chip resistor | 47 | 5 % 0.063 W 0402 |
| R259 | 1430804 | Chip resistor | 100 k | 5 % 0.063 W 0402 |
| R260 | 1620023 | Res network | 0w06 2x47k j | 0404 |
| R261 | 1430740 | Chip resistor | 330 | 5 % 0.063 W 0402 |
| R264 | 1620027 | Res network | 0w06 2x47r j | 0404 |
| R265 | 1430762 | Chip resistor | 2.2 k | 5 % 0.063 W 0402 |
| R266 | 1430762 | Chip resistor | 2.2 k | 5 % 0.063 W 0402 |
| R267 | 1430762 | Chip resistor | 2.2 k | 5 % 0.063 W 0402 |
| R268 | 1430812 | Chip resistor | 220 k | 5 % 0.063 W 0402 |

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|------|---------|---------------|--------------|------------------|
| R270 | 1430812 | Chip resistor | 220 k | 5 % 0.063 W 0402 |
| R272 | 1430744 | Chip resistor | 470 | 5 % 0.063 W 0402 |
| R273 | 1430710 | Chip resistor | 22 | 5 % 0.063 W 0402 |
| R275 | 1620031 | Res network | 0w06 2x1k0 j | 0404 |
| R701 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R725 | 1430710 | Chip resistor | 22 | 5 % 0.063 W 0402 |
| R731 | 1430820 | Chip resistor | 470 k | 5 % 0.063 W 0402 |
| R741 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R742 | 1430784 | Chip resistor | 15 k | 5 % 0.063 W 0402 |
| R743 | 1430730 | Chip resistor | 150 | 5 % 0.063 W 0402 |
| R744 | 1430730 | Chip resistor | 150 | 5 % 0.063 W 0402 |
| R745 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R746 | 1430740 | Chip resistor | 330 | 5 % 0.063 W 0402 |
| R747 | 1430770 | Chip resistor | 4.7 k | 5 % 0.063 W 0402 |
| R751 | 1430812 | Chip resistor | 220 k | 5 % 0.063 W 0402 |
| R752 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R756 | 1430804 | Chip resistor | 100 k | 5 % 0.063 W 0402 |
| R758 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R759 | 1620023 | Res network | 0w06 2x47k j | 0404 |
| R760 | 1620023 | Res network | 0w06 2x47k j | 0404 |
| R761 | 1430812 | Chip resistor | 220 k | 5 % 0.063 W 0402 |
| R762 | 1430851 | Chip resistor | 15 k | 2 % 0.063 W 0402 |
| R763 | 1430758 | Chip resistor | 1.5 k | 5 % 0.063 W 0402 |
| R764 | 1430744 | Chip resistor | 470 | 5 % 0.063 W 0402 |
| R765 | 1430744 | Chip resistor | 470 | 5 % 0.063 W 0402 |
| R768 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R770 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R771 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R772 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R774 | 1430764 | Chip resistor | 3.3 k | 5 % 0.063 W 0402 |
| R775 | 1430804 | Chip resistor | 100 k | 5 % 0.063 W 0402 |
| R776 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R786 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R787 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R788 | 1430744 | Chip resistor | 470 | 5 % 0.063 W 0402 |
| R789 | 1430744 | Chip resistor | 470 | 5 % 0.063 W 0402 |
| R801 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R802 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R803 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R804 | 1430804 | Chip resistor | 100 k | 5 % 0.063 W 0402 |
| R805 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R806 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R807 | 1430762 | Chip resistor | 2.2 k | 5 % 0.063 W 0402 |
| R808 | 1430772 | Chip resistor | 5.6 k | 5 % 0.063 W 0402 |
| R809 | 1430740 | Chip resistor | 330 | 5 % 0.063 W 0402 |
| R810 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R811 | 1430788 | Chip resistor | 22 k | 5 % 0.063 W 0402 |

System Module

Technical Documentation

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|------|---------|---------------|--------------|------------------|
| R812 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R813 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R814 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R821 | 1430710 | Chip resistor | 22 | 5 % 0.063 W 0402 |
| R822 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R823 | 1430710 | Chip resistor | 22 | 5 % 0.063 W 0402 |
| R830 | 1430792 | Chip resistor | 33 k | 5 % 0.063 W 0402 |
| R831 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R832 | 1430734 | Chip resistor | 220 | 5 % 0.063 W 0402 |
| R833 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R840 | 1430784 | Chip resistor | 15 k | 5 % 0.063 W 0402 |
| R841 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R842 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R843 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R850 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R851 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R852 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R853 | 1430784 | Chip resistor | 15 k | 5 % 0.063 W 0402 |
| R854 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R855 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R860 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R861 | 1430764 | Chip resistor | 3.3 k | 5 % 0.063 W 0402 |
| R862 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R864 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R865 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R866 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R867 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R880 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R881 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R886 | 1430772 | Chip resistor | 5.6 k | 5 % 0.063 W 0402 |
| R893 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R895 | 1430804 | Chip resistor | 100 k | 5 % 0.063 W 0402 |
| R901 | 1430700 | Chip resistor | 10 | 5 % 0.063 W 0402 |
| R904 | 1430754 | Chip resistor | 1.0 k | 5 % 0.063 W 0402 |
| R906 | 1430718 | Chip resistor | 47 | 5 % 0.063 W 0402 |
| R907 | 1430690 | Chip jumper | | 0402 |
| R910 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R911 | 1430690 | Chip jumper | | 0402 |
| R930 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R931 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R933 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R934 | 1620101 | Res network | 0w06 2x470r | 0404 |
| R936 | 1620031 | Res network | 0w06 2x1k0 j | 0404 |
| R937 | 1620029 | Res network | 0w06 2x4k7 j | 0404 |
| R938 | 1430778 | Chip resistor | 10 k | 5 % 0.063 W 0402 |
| R939 | 1620029 | Res network | 0w06 2x4k7 j | 0404 |
| R940 | 1800659 | NTC resistor | 47 k | 10 % 0.12 W 0805 |

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|------|---------|---------------|-------|------------------|
| R941 | 1430726 | Chip resistor | 100 | 5 % 0.063 W 0402 |
| R942 | 1430788 | Chip resistor | 22 k | 5 % 0.063 W 0402 |
| R943 | 1430740 | Chip resistor | 330 | 5 % 0.063 W 0402 |
| R960 | 1430770 | Chip resistor | 4.7 k | 5 % 0.063 W 0402 |
| R961 | 1430710 | Chip resistor | 22 | 5 % 0.063 W 0402 |
| R980 | 1430740 | Chip resistor | 330 | 5 % 0.063 W 0402 |
| R982 | 1430690 | Chip jumper | | 0402 |
| C101 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C103 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C104 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C105 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C150 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C151 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C154 | 2320548 | Ceramic cap. | 33 p | 5 % 50 V 0402 |
| C155 | 2320540 | Ceramic cap. | 15 p | 5 % 50 V 0402 |
| C157 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C158 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C159 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C160 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C161 | 2310781 | Ceramic cap. | 220 n | 10 % 16 V 0805 |
| C162 | 2310781 | Ceramic cap. | 220 n | 10 % 16 V 0805 |
| C163 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C164 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C166 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C167 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C169 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C170 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C171 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C172 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C173 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C174 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C175 | 2312403 | Ceramic cap. | 2.2 u | 10 % 10 V 1206 |
| C176 | 2312403 | Ceramic cap. | 2.2 u | 10 % 10 V 1206 |
| C177 | 2610005 | Tantalum cap. | 10 u | 20 % 16 V |
| C178 | 2610005 | Tantalum cap. | 10 u | 20 % 16 V |
| C179 | 2604127 | Tantalum cap. | 1.0 u | 20 % 35 V |
| C180 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C181 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C185 | 2610005 | Tantalum cap. | 10 u | 20 % 16 V |
| C187 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C188 | 2610005 | Tantalum cap. | 10 u | 20 % 16 V |
| C189 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C190 | 2320508 | Ceramic cap. | 1.0 p | 0.25 % 50 V 0402 |
| C200 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C201 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C202 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C203 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |

System Module

Technical Documentation

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|------|---------|--------------|-------|------------------|
| C204 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C205 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C206 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C207 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C209 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C210 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C212 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C214 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C217 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C218 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C219 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C220 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C221 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C223 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C225 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C227 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C228 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C250 | 2320564 | Ceramic cap. | 150 p | 5 % 50 V 0402 |
| C255 | 2320564 | Ceramic cap. | 150 p | 5 % 50 V 0402 |
| C256 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C258 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C259 | 2312296 | Ceramic cap. | | Y5 V 1210 |
| C260 | 2312296 | Ceramic cap. | | Y5 V 1210 |
| C261 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C262 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C263 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C264 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C265 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C266 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C268 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C269 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C270 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C271 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C273 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C275 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C277 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C278 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C279 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C281 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C282 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C283 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C284 | 2320544 | Ceramic cap. | 22 p | 5 % 50 V 0402 |
| C285 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C286 | 2320469 | Ceramic cap. | | Y5 V 0603 |
| C701 | 2320508 | Ceramic cap. | 1.0 p | 0.25 % 50 V 0402 |
| C702 | 2320524 | Ceramic cap. | 3.3 p | 0.25 % 50 V 0402 |
| C703 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |

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|------|---------|--------------|-------|------------------|
| C706 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |
| C707 | 2320518 | Ceramic cap. | 1.8 p | 0.25 % 50 V 0402 |
| C708 | 2320520 | Ceramic cap. | 2.2 p | 0.25 % 50 V 0402 |
| C709 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |
| C710 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C729 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C733 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C734 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C735 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C739 | 2320520 | Ceramic cap. | 2.2 p | 0.25 % 50 V 0402 |
| C741 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C743 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C744 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C745 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C746 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C747 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C748 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C755 | 2320728 | Ceramic cap. | 220 p | 10 % 50 V 0402 |
| C756 | 2320618 | Ceramic cap. | 4.7 n | 5 % 25 V 0402 |
| C757 | 2320552 | Ceramic cap. | 47 p | 5 % 50 V 0402 |
| C758 | 2320552 | Ceramic cap. | 47 p | 5 % 50 V 0402 |
| C759 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C760 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C761 | 2320618 | Ceramic cap. | 4.7 n | 5 % 25 V 0402 |
| C762 | 2320618 | Ceramic cap. | 4.7 n | 5 % 25 V 0402 |
| C763 | 2320618 | Ceramic cap. | 4.7 n | 5 % 25 V 0402 |
| C764 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C765 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C766 | 2320592 | Ceramic cap. | 2.2 n | 5 % 50 V 0402 |
| C767 | 2320618 | Ceramic cap. | 4.7 n | 5 % 25 V 0402 |
| C768 | 2320618 | Ceramic cap. | 4.7 n | 5 % 25 V 0402 |
| C769 | 2320618 | Ceramic cap. | 4.7 n | 5 % 25 V 0402 |
| C770 | 2320618 | Ceramic cap. | 4.7 n | 5 % 25 V 0402 |
| C773 | 2320618 | Ceramic cap. | 4.7 n | 5 % 25 V 0402 |
| C778 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C779 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C780 | 2320586 | Ceramic cap. | 1.2 n | 5 % 50 V 0402 |
| C781 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C782 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C783 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C784 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C785 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C786 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C787 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C788 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C789 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C790 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |

System Module

Technical Documentation

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|------|---------|---------------|-------|------------------|
| C791 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C792 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C793 | 2310424 | Ceramic cap. | 100 p | 5 % 50 V 0805 |
| C794 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C795 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C796 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C797 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C798 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C801 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C802 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C803 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C805 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C806 | 2320604 | Ceramic cap. | 18 p | 5 % 50 V 0402 |
| C807 | 2611668 | Tantalum cap. | 4.7 u | 20 % 10 V |
| C808 | 2320540 | Ceramic cap. | 15 p | 5 % 50 V 0402 |
| C809 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C810 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C811 | 2320520 | Ceramic cap. | 2.2 p | 0.25 % 50 V 0402 |
| C815 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C816 | 2320508 | Ceramic cap. | 1.0 p | 0.25 % 50 V 0402 |
| C821 | 2320508 | Ceramic cap. | 1.0 p | 0.25 % 50 V 0402 |
| C824 | 2610005 | Tantalum cap. | 10 u | 20 % 16 V |
| C825 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C830 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C831 | 2310248 | Ceramic cap. | 4.7 n | 5 % 50 V 1206 |
| C833 | 2320564 | Ceramic cap. | 150 p | 5 % 50 V 0402 |
| C834 | 2320564 | Ceramic cap. | 150 p | 5 % 50 V 0402 |
| C840 | 2320548 | Ceramic cap. | 33 p | 5 % 50 V 0402 |
| C841 | 2320728 | Ceramic cap. | 220 p | 10 % 50 V 0402 |
| C842 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C843 | 2320532 | Ceramic cap. | 6.8 p | 0.25 % 50 V 0402 |
| C844 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C845 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C850 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C851 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C853 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C854 | 2320524 | Ceramic cap. | 3.3 p | 0.25 % 50 V 0402 |
| C855 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C856 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C857 | 2320728 | Ceramic cap. | 220 p | 10 % 50 V 0402 |
| C858 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C860 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C861 | 2420017 | Ceramic cap. | 18 n | 5 % 16 V 1206 |
| C864 | 2320564 | Ceramic cap. | 150 p | 5 % 50 V 0402 |
| C865 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C866 | 2320564 | Ceramic cap. | 150 p | 5 % 50 V 0402 |
| C867 | 2611668 | Tantalum cap. | 4.7 u | 20 % 10 V |

3.2x1.6x1.6

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|------|---------|---------------|-------|------------------|
| C868 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C869 | 2320522 | Ceramic cap. | 2.7 p | 0.25 % 50 V 0402 |
| C881 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C882 | 2611668 | Tantalum cap. | 4.7 u | 20 % 10 V |
| C885 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C886 | 2320584 | Ceramic cap. | 1.0 n | 5 % 50 V 0402 |
| C887 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C898 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C900 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C901 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C902 | 2320552 | Ceramic cap. | 47 p | 5 % 50 V 0402 |
| C903 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |
| C904 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C905 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C906 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C907 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C908 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C910 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C914 | 2312401 | Ceramic cap. | 1.0 u | 10 % 10 V 0805 |
| C917 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C920 | 2320917 | Ceramic cap. | | 25 V 0402 |
| C921 | 2320552 | Ceramic cap. | 47 p | 5 % 50 V 0402 |
| C923 | 2320941 | Ceramic cap. | | 10 V 0402 |
| C924 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C925 | 2320913 | Ceramic cap. | | 25 V 0402 |
| C926 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C927 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C928 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C929 | 2320552 | Ceramic cap. | 47 p | 5 % 50 V 0402 |
| C930 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C931 | 2320524 | Ceramic cap. | 3.3 p | 0.25 % 50 V 0402 |
| C932 | 2320508 | Ceramic cap. | 1.0 p | 0.25 % 50 V 0402 |
| C933 | 2320131 | Ceramic cap. | 33 n | 10 % 16 V 0603 |
| C934 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |
| C937 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |
| C938 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C939 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |
| C940 | 2320602 | Ceramic cap. | 4.7 p | 0.25 % 50 V 0402 |
| C941 | 2320508 | Ceramic cap. | 1.0 p | 0.25 % 50 V 0402 |
| C943 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |
| C950 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C951 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C952 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C953 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C954 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C955 | 2320516 | Ceramic cap. | 1.5 p | 0.25 % 50 V 0402 |

System Module

Technical Documentation

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|------|---------|-----------------------------------|-------|-------------------|
| C960 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C961 | 2320546 | Ceramic cap. | 27 p | 5 % 50 V 0402 |
| C962 | 2320552 | Ceramic cap. | 47 p | 5 % 50 V 0402 |
| C963 | 2320620 | Ceramic cap. | 10 n | 5 % 16 V 0402 |
| C964 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C965 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C967 | 2320915 | Ceramic cap. | | 25 V 0402 |
| C968 | 2320921 | Ceramic cap. | | 25 V 0402 |
| C969 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C970 | 2320931 | Ceramic cap. | | 25 V 0402 |
| C972 | 2320779 | Ceramic cap. | 100 n | 10 % 16 V 0603 |
| C980 | 2320520 | Ceramic cap. | 2.2 p | 0.25 % 50 V 0402 |
| C981 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C982 | 2320560 | Ceramic cap. | 100 p | 5 % 50 V 0402 |
| C983 | 2320536 | Ceramic cap. | 10 p | 5 % 50 V 0402 |
| C990 | 2320602 | Ceramic cap. | 4.7 p | 0.25 % 50 V 0402 |
| C992 | 2320526 | Ceramic cap. | 3.9 p | 0.25 % 50 V 0402 |
| L103 | 3640035 | Filt z>450r/100m 0r7max 0.2a 0603 | | 0603 |
| L104 | 3640035 | Filt z>450r/100m 0r7max 0.2a 0603 | | 0603 |
| L105 | 3640035 | Filt z>450r/100m 0r7max 0.2a 0603 | | 0603 |
| L150 | 3203701 | Ferrite bead 33r/100mhz | 0805 | 0805 |
| L701 | 3643045 | Chip coil | 27 n | 5 % Q=45/250 MHz |
| 0805 | | | | |
| L702 | 3643101 | Chip coil | 270 n | 10 % Q=20/25 MHz |
| 0805 | | | | |
| L703 | 3640051 | Chip coil | 12 n | 5 % Q=45/250 MHz |
| 0805 | | | | |
| L705 | 3608319 | Chip coil | 270 n | 10 % 1206 |
| L721 | 3641521 | Chip coil | 6 n | 5 % Q=50/250 MHz |
| 0805 | | | | |
| L723 | 3645157 | Chip coil | 100 n | 10 % Q=12/100 MHz |
| 0603 | | | | |
| L724 | 3608407 | Chip coil | 470 n | 5 % 1206 |
| L741 | 3641620 | Chip coil | 180 n | 5 % Q=35/100 MHz |
| 0805 | | | | |
| L750 | 3643067 | Chip coil | 100 u | 5 % Q=15/796 kHz |
| 1008 | | | | |
| L801 | 3645043 | Chip coil | 47 n | 2 % Q=40/200 MHz |
| 0805 | | | | |
| L840 | 3641620 | Chip coil | 180 n | 5 % Q=35/100 MHz |
| 0805 | | | | |
| L841 | 3641575 | Chip coil | 100 n | 5 % Q=40/150 MHz |
| 0805 | | | | |
| L850 | 3645045 | Chip coil | | 10 % Q=45/10 MHz |
| 0805 | | | | |
| L900 | 3645157 | Chip coil | 100 n | 10 % Q=12/100 MHz |
| 0603 | | | | |

Technical Documentation

System Module

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|--------------|---------|-----------------------------------|-----------------|-------------------|
| L901 0603 | 3645005 | Chip coil | 15 n | 10 % Q=12/100 MHz |
| L902 0603 | 3645005 | Chip coil | 15 n | 10 % Q=12/100 MHz |
| L903 0603 | 3645005 | Chip coil | 15 n | 10 % Q=12/100 MHz |
| L904 0603 | 3645157 | Chip coil | 100 n | 10 % Q=12/100 MHz |
| L905 0603 | 3645005 | Chip coil | 15 n | 10 % Q=12/100 MHz |
| L906 0603 | 3645157 | Chip coil | 100 n | 10 % Q=12/100 MHz |
| L907 | 3203701 | Ferrite bead 33r/100mhz | 0805 | 0805 |
| L930 0603 | 3645157 | Chip coil | 100 n | 10 % Q=12/100 MHz |
| L931 0603 | 3645157 | Chip coil | 100 n | 10 % Q=12/100 MHz |
| L940 0603 | 3645001 | Chip coil | 4 n | 10 % Q=10/100 MHz |
| L950 0603 | 3645005 | Chip coil | 15 n | 10 % Q=12/100 MHz |
| L951 0603 | 3645001 | Chip coil | 4 n | 10 % Q=10/100 MHz |
| L960 0603 | 3645171 | Chip coil | 6 n | 10 % Q=10/100 MHz |
| L961 0603 | 3645005 | Chip coil | 15 n | 10 % Q=12/100 MHz |
| L962 0603 | 3645005 | Chip coil | 15 n | 10 % Q=12/100 MHz |
| L964 0805 | 3643001 | Chip coil | 10 n | 5 % Q=30/250 MHz |
| L980 0603 | 3645157 | Chip coil | 100 n | 10 % Q=12/100 MHz |
| L993 0805 | 3640013 | Chip coil | 8 n | 5 % Q=50/250 MHz |
| B150 | 4510003 | Crystal | 32.768 k | +/-20PPM 8x3.8 |
| G820 | 4350121 | Vco 985.2-1010.2mhz 2.8v 8ma tdma | | TDMA |
| G850 | 4510165 | VCTCXO | 19.44 M | +/-2.5PPM 2.8V |
| G860 | 4350117 | Vco 2046-2106mhz 2.8v 10ma | | |
| F150 | 5119019 | SM, fuse f 1.5a 32v | 0603 | |
| Z100 | 3640069 | Filt 47pf 25v 0r01 6a | 1206 | |
| Z701 | 4510121 | Saw filter | 881.5+-12.5 M | /3.5DB 4X4 |
| Z726 | 4550053 | Cer.filt 1960+-30mhz | 8.4x5.95 | 8.4x5.95 |
| Z741 | 4511011 | Saw filter | 116.19+-0.015 M | 9.3X5 |
| Z750 | 4550057 | Cer.filt 450+-12.5khz | 11.8x7.5 | 11.8x7.5 |
| Z900 | 4511031 | Saw filter | 161.2/196.2 M | 5X5 |
| Z901 | 4510127 | Saw filter | 836.5+-12.5 M | /3.5DB 4X4 |

System Module

Technical Documentation

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|--------|---------|-----------------------------------|------------------|-------------------|
| Z910 | 4512013 | Dupl 824-849/869-894mhz | | 19.2x11.2 |
| Z950 | 4550049 | Cer.filt 1880+-30mhz/4.5db8.4x6.2 | | |
| Z951 | 4511023 | Saw filter | 1880+-30 M | /4.2DB 3X3 |
| Z960 | 4512069 | Dupl 1850-1910/1930-1990mhz | | 19x11 |
| Z961 | 3640069 | Filt 47pf 25v 0r01 6a | | 1206 |
| V150 | 4210037 | Transistor BCW30 | pnP 32 V 0.1 A | SOT23 |
| V151 | 4110067 | Schottky diode | MBR0520L | 20 V 0.5 A SOD123 |
| V152 | 4210052 | Transistor | DTC114EE | npn RB V EM3 |
| V153 | 4211202 | DM MosFet | p-ch 50 V 0.13 A | SOT23 |
| V200 | 4110072 | Diode x 2 | BAV99W | 70 V 0.2 A SOT323 |
| V201 | 4110072 | Diode x 2 | BAV99W | 70 V 0.2 A SOT323 |
| V202 | 4110072 | Diode x 2 | BAV99W | 70 V 0.2 A SOT323 |
| V250 | 4210100 | Transistor | BC848W | npn 30 V SOT323 |
| V251 | 4210052 | Transistor | DTC114EE | npn RB V EM3 |
| V253 | 4211231 | MosFet | NDS33 | SOT23 |
| V254 | 4110072 | Diode x 2 | BAV99W | 70 V 0.2 A SOT323 |
| V741 | 4210066 | Transistor | BFR93AW | npn 12 V 35 mA |
| SOT323 | | | | |
| V800 | 4219903 | Transistor x 2 | BFM505 | npn 20 V 20V18 mA |
| SOT363 | | | | |
| V801 | 4112441 | Pin diode | BA592 | 35 V 0.1 A SOD323 |
| V802 | 4110018 | Cap. diode | BB135 | 30 V SOD323 |
| V803 | 4110027 | Cap. diode | SV239 | |
| V840 | 4210066 | Transistor | BFR93AW | npn 12 V 35 mA |
| SOT323 | | | | |
| V850 | 4210100 | Transistor | BC848W | npn 30 V SOT323 |
| V929 | 4110008 | Schottky diode | HSMS2825 | 8 V SOT143 |
| V930 | 4110008 | Schottky diode | HSMS2825 | 8 V SOT143 |
| V932 | 4112469 | Pindix2 bar64-07 200v 0.1a sot143 | | SOT143 |
| D200 | 4340397 | IC, SRAM | | STSOP3 |
| D201 | 4340261 | IC, flash mem. | | TSO48 |
| D202 | 4370249 | Mad1 rom2 f711857 c12 tqfp144 | | TQFP144 |
| D203 | 4340357 | IC, EEPROM | | SO8 |
| D801 | 4340126 | IC, 1xnand 2input cmos ssTC7S00F | | SSO5 |
| N150 | 4370391 | Ccont2h dct3 bb asic | | TQFP64 |
| N151 | 4370165 | Chaps charger control | | SO16 |
| N250 | 4370413 | Cobba_d b05 bb asic damp | | TQFP64 |
| N701 | 4370063 | Sc3918 tdma rec 869-894mhz | | QSOP16 |
| N702 | 4340247 | IC, regulator | MC33765 | 2.8 V TSSOP16 |
| N721 | 4370065 | Sc3919 tdma rec 1930-1990 | | QSOP16 |
| N750 | 4370273 | PLUSSA txmod+rxif+2pll | | TQFP64 |
| N880 | 4340237 | IC, PLL | UMA1021M | SSOP20 |
| N900 | 4340171 | IC, upconv 1.9ghz 3v so uPC8106T | | SO6S |
| N902 | 4340515 | Fmm5024ml power amp 800mhz | | SSO6 |
| N903 | 4370311 | Rf9103p1 pw amp 824-849 mhz | | |
| N950 | 4340517 | Fmm5026ml power amp 1900mhz | | SSO6 |
| N960 | 4370313 | Rf9111p1 pw amp 1850-1910 mhz | | |

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|------|---------|-----------------------------------|----------|
| N980 | 4340381 | Mrfic1813 upconvgaas 1.9g tssop16 | TSSOP16 |
| X100 | 5469061 | SM, system conn 6af+3dc+mic+jack | |
| X102 | 5460021 | SM, conn 2x14m spring p1.0 pcb/p | PCB/PCB |
| X104 | 5469069 | SM, batt conn 2pol spr p3.5 100v | 100V2A |
| X105 | 5469069 | SM, batt conn 2pol spr p3.5 100v | 100V2A |
| X991 | 5429007 | SM, coax conn m sw 50r | 0.4-2ghz |
| A950 | 9517018 | Shield assembly 3m dmc01006 hd96 | HD963 |
| | 9380753 | Bar code label dmd03311 27x6.5 | 27x6.5 |
| | 9854295 | PCB UT4R 41.0X124.3X0.9 M6 4/PA | |

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